



THCV243

SerDes transmitter with bi-directional transceiver

1 General Description

THCV243 is designed to support 1080p60 2Mpixel uncompressed video data over 100ohm differential STP or single-end 50ohm Coaxial cable between camera and processor by V-by-One® HS.

THCV243 supports a MIPI CSI-2. Each CSI-2 data lane can transmit up to 1.2Gbps/lane. Virtual channel is supported.

High-speed V-by-One® HS lane can transmit up to 1080p60fps. The maximum serial data rate is 4Gbps.

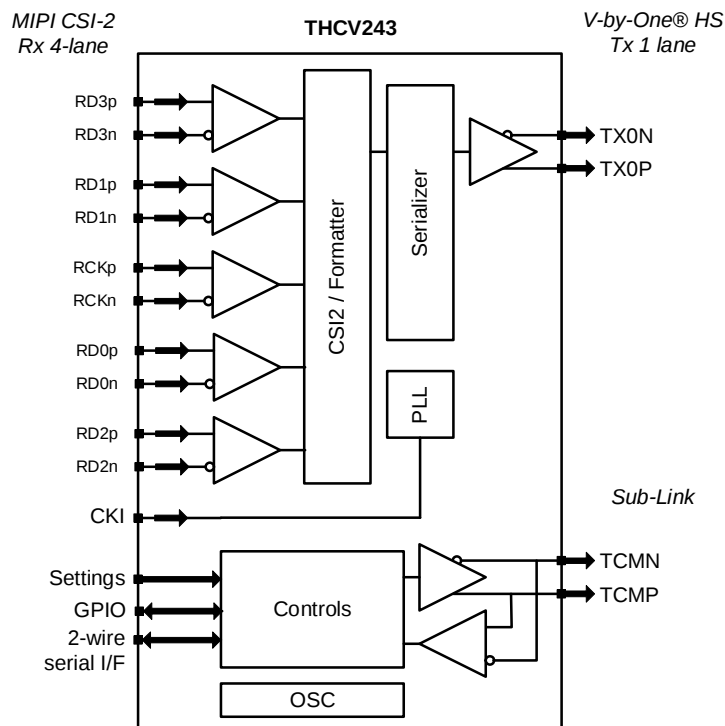
THCV243 is capable to control and monitor camera module from remote ECU via GPIO or 1Mbps 2-wire serial interface.

Several fault and error detection function including CRC provides hardware functional safety design.

2 Features

- MIPI CSI-2 with 1,2 or 4-lane input
- MIPI D-PHY supports 80Mbps~1.2Gbps
- Video formats: RAW8/10/12/14/16/20, YUV422/420, RGB888/666/565, JPEG, User-defined generic 8-bit
- V-by-One® HS 400Mbps~4Gbps
- V-by-One® HS standard version1.5
- Reference clock input CKI range 10~40MHz shareable with video source CMOS sensor
- Wide range IO voltage from 1.7V to 3.6V
- Additional spread spectrum to reduce EMI
- 2-wire serial interface 1Mbps bridge function
- Remote GPIO/UART control and monitoring
- Error detection including CRC and notification
- CSP35 2.1x2.9mm 0.4mm pitch package
- Compliant with RoHS and REACH

3 Block Diagram



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5 Pin Description

Pin Name	Pin #	type*	Description
RD3P/N	G5 / F5	MI	MIPI lane3 differential data input
RD1P/N	G4 / F4	MI	MIPI lane1 differential data input
RCKP/N	G3 / F3	MI	MIPI differential clock input
RD0P/N	G2 / F2	MI	MIPI lane0 differential data input
RD2P/N	G1 / F1	MI	MIPI lane2 differential data input
TX0P/N	A3 / A4	CO	V-by-One® HS lane0 High-speed CML signal output
TCMP/N	A1 / A2	CB/B	TCMP/N (PDN1=1): CML Bi-directional Input/Output(Sub-Link). NC (PDN1=0): Not Connected. Must be open.
SCL	D4	B	2-wire serial Master/Slave SCL
SDA	C4	B	2-wire serial Master/Slave SDA
PDN0	D5	I	Whole IC Power Down 0 : Power Down 1 : Normal Operation
PDN1	B2	I	Sub-Link Power Down 0 : Sub-Link Power Down 1 : Sub-Link Normal Operation
TEST	B3	I	Test pin. Must be tied to Ground for normal operation.
CKI	D1	I	Reference Clock Input
CKO	E1	O	Reference Clock Output
LOCKN	B5	I	LOCK detect input Negative polarity If external LOCKN connection is used, it is supposed to be connected to Rx LOCKN with a 30kΩ pull-up resistor.
GPIO0	D2	B	GPIO0
GPIO1	C1	B	GPIO1
GPIO2	C2	B	GPIO2
GPIO3	B1	B	GPIO3
MSSEL	C5	I	MSSEL (PDN1=1): Sub-Link Master/Slave Select 0 : Sub-Link Master side(inside 2-wire serial I/F is slave) 1 : Sub-Link Slave side(inside 2-wire serial I/F is master) Sub-Link Master is connected to HOST MCU. HTPDN (PDN1=0): HoT Plug Detect input Negative polarity Must be connected to Rx HTPDN with a 30kΩ pull-up resistor.
AIN	B4	I	Select Slave Address 0 : 2wire serial Address = 7'b000_1011 1 : 2wire serial Address = 7'b011_0100
INT	E5	O	Interrupt signal output. It must be connected with a pull-up resistor. 0 : Interrupt occurred 1 : Steady state
VDDL0P	E2	P	Power supply Pin 1.2V
VDDM	E4	P	MIPI Power supply Pin 1.2V
VDDA	A5	P	Analog Power supply Pin 1.2V
VDDH	C3	P	Power supply Pin 1.8~3.3V
GND	D3, E3	G	Exposed Pad Ground : Must be tied to Ground

*type symbol

MI=MIPI Input, CO=CML Output

CB=CML Bi-directional input/output

B=1.8~3.3V LVCMOS Bi-directional input/output, I=1.8~3.3v LVCMOS Input, O=1.8~3.3v LVCMOS Output

P=Power, G=Ground

6 Functional Description

6.1 Functional Overview

THCV243 can receive MIPI CSI-2 video and transmit it to over 15m length. With High Speed CML SerDes, high reliability and robustness encoding scheme and CDR (Clock and Data Recovery) architecture, the THCV243 enables to transmit RAW/YUV/RGB/JPEG/Generic8bit data through Main-Link by single 100ohm differential pair or 50ohm Coax cable with minimal external components. Maximum supported resolution is horizontal active 3840 pixels format. In addition, the THCV243 has Sub-Link which enables bi-directional transmission of 2-wire serial interface signals, GPIO signals and also HTPDN/LOCKN signals for Main-Link through the other 1-pair of CML-Line. The THCV243 system is able to watch peripheral devices and to control them via 2-wire serial interface or GPIOs. They also can report interrupt events caused by change of GPIO inputs and internal statuses such as CRC error.

6.2 Reference clock supply

Reference clock supply CKI is required since MIPI CSI-2 clock stream will not always be continuous. CKI frequency examples are 24MHz, 27MHz and 37.125MHz.

To supply the same oscillator clock as CMOS sensor to THCV243 is recommended.

See Figure 1.

Physical layout artwork of oscillator clock trace is supposed to be designed to shorten stub branch as possible.

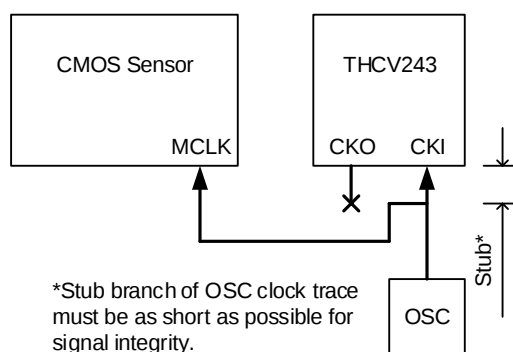


Figure 1. Reference clock supply basic method

Another alternative is to make use of THCV243 CKO internal clock buffer function.

CKO clock buffer may strengthen clock drive ability in order to compensate clock signal loss in large structure. On the other hand, additional clock buffer may become another EMI emission source as trade-off.

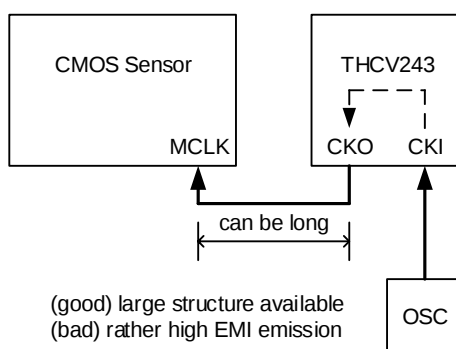


Figure 2. Reference clock supply clock buffer method (optional)

6.3 MIPI input setting

Setting of MIPI input can be configurable by 2-wire access to internal register.

Lane0 of MIPI input must always be used regardless of configuration as an obligation.

Table 1. MIPI input setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1025	[0]	R_RX_PN_SW	1	R/W	MIPI P/N sw ap	1'h0
0x1026	[7:6]	R_RX_LANE_SEL0	2	R/W	MIPI Data Lane RX0P/RX0N pin input mapping/sw ap select MIPI standard format lane# assignment used on RX0P/RX0N input The same setting as R_RX_LANE_SEL1/2/3 is prohibited.	2'h0
0x1026	[5:4]	R_RX_LANE_SEL1	2	R/W	MIPI Data Lane RX1P/RX1N pin input mapping/sw ap select MIPI standard format lane# assignment used on RX1P/RX1N input The same setting as R_RX_LANE_SEL0/2/3 is prohibited.	2'h1
0x1026	[3:2]	R_RX_LANE_SEL2	2	R/W	MIPI Data Lane RX2P/RX2N pin input mapping/sw ap select MIPI standard format lane# assignment used on RX2P/RX2N input The same setting as R_RX_LANE_SEL0/1/3 is prohibited.	2'h2
0x1026	[1:0]	R_RX_LANE_SEL3	2	R/W	MIPI Data Lane RX3P/RX3N pin input mapping/sw ap select MIPI standard format lane# assignment used on RX3P/RX3N input The same setting as R_RX_LANE_SEL0/1/2 is prohibited.	2'h3
0x102C	[0]	R_RX_CLKLANE_EN	1	R/W	MIPI Clock Lane Enable 0:Disable 1:Enable	1'h0
0x102D	[4]	R_RX_DATA_LANE_EN	1	R/W	MIPI Data Lane Enable 0:Disable 1:Enable, following R_RX_LANE_SEL_EN	1'h0
0x102D	[1:0]	R_RX_LANE_SEL_EN	2	R/W	MIPI Valid Data Lane number select 00:1Lane (lane0 Enable) 01,10:2Lane (lane<1:0> Enable) 11:4Lane (lane<3:0> Enable)	2'h3

6.4 HTPDN/LOCKN

Hot-Plug Function

HTPDN indicates Main-Link connect condition between Transmitter and Receiver. HTPDN of Transmitter side is high when Receiver is not active or not connected. Then Transmitter can enter into power down mode. HTPDN is set to Low by the Receiver when Receiver is active and connects to the Transmitter, and then Transmitter must start up and transmit CDR training pattern for link training. HTPDN is open drain output at the receiver side. Transmitter side needs Pull-up resistor.

There is an application option to omit HTPDN connection between Transmitter and Receiver. In this case, HTPDN at Transmitter side should always be at Low.

Lock Detect Function

LOCKN indicates whether CDR PLL of Main-Link is in lock status or not. LOCKN at Transmitter input is set to High by pull-up resistor when Receiver is not active or in CDR PLL training. LOCKN is set to Low by Receiver when CDR lock is completed. After that the CDR training mode finishes and then Transmitter shifts to the normal mode. LOCKN of Receiver is open drain. Transmitter side needs pull-up resistor.

When an application omits HTPDN, LOCKN signal should only be considered with HTPDN pulled low by Receiver.

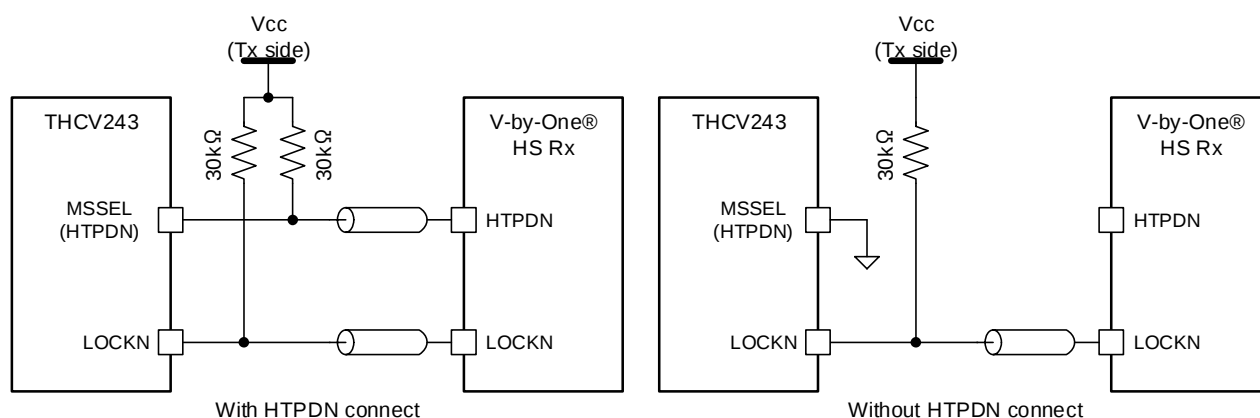


Figure 3. Physical wire connection for wired Hot-plug and Lock detect scheme

It will need same GND potential reference between transmitter and receiver device to connect HTPDN and LOCKN pins directly like above. HTPDN and LOCKN can also be transmitted via Sub-Link without physical wire connection. Assignment can be configurable by 2-wire access to internal register.

Table 2. HTPDN/LOCKN register

Addr(h)	Bits	Register	width	R/W	Description	Default
0x101D	[1:0]	R_HTPDN_SEL	2	R/W	V-by-One® HS HTPDN assignment 00:Sub-Link at PDN1=1 / HTPDN pin input at PDN1=0, 01:Reserved, 10:forced Low , 11:forced High	2'h0
0x101E	[5:4]	R_LOCKN0_SEL	2	R/W	V-by-One® HS LOCKN assignment 00:Sub-Link, 01:LOCKN pin input, 10:forced Low , 11:forced High	2'h0

6.5 V-by-One® HS output setting

Setting of V-by-One® HS output format can be configurable by 2-wire access to internal register.

Table 3. V-by-One® HS output format setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1001	[6:4]	R_OUTPUT_FMT	3	R/W	V-by-One® HS output format setting 000: Main-Link Private Format (MPRF) 001: V-by-One® HS Standard YUV422(16bit)/RAW8 010: V-by-One® HS Standard RGB888 011: V-by-One® HS Standard RGB565 100: V-by-One® HS Standard RAW10 Mode1 101: V-by-One® HS Standard RAW12 Mode1 110: V-by-One® HS Standard RAW10 Mode2 111: V-by-One® HS Standard RAW12 Mode2	3'h0
0x1002	[5]	R_HFSEL	1	R/W	V-by-One® HS HFSEL (High Freq. SElect) mode Enable 0: HF Mode Disable 1: HF Mode Enable	1'h0
0x1055	[1:0]	R_BITMAP_SEL	2	R/W	V-by-One® HS output data mapping select 00: MAP1, 01: MAP2, 10: MAP3, 11: MAP4	2'h0

6.5.1 MPRF (Main-Link Private Format)

MPRF format encoding preserves original data packet input to THCV243 and output the data packet from counterpart V-by-One® HS receiver. The counterpart receiver must have installed MPRF format decoder like THCV242 because MPRF is not standard format.

Output V-by-One® HS Byte Mode is 4Byte Mode.

Video formats: RAW8/10/12/14/16/20, YUV422/420, RGB888/666/565, JPEG, and User-defined generic 8-bit are all supported with MPRF.

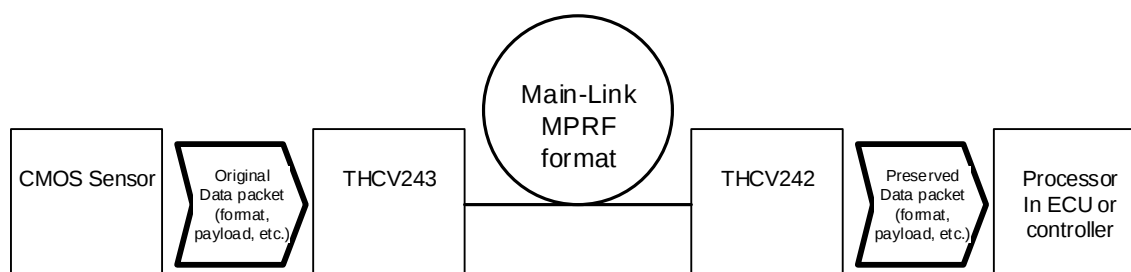


Figure 4. MPRF (Main-Link Private Format)

6.5.2 V-by-One® HS standard format

THCV243 output format capabilities as transmitter are shown as follows. D[31:0] indicates V-by-One® HS standard version1.5 Packer packet definition. Data can be transmitted normally only when both transmitter and receiver are set to the same available format. Some of the THCV243 format may not be supported by particular counterpart receiver because THCV243 prepares multiple formats that suit to multiple receiver devices alternatives.

Table 4. V-by-One® HS output data mapping format 1/3

R OUTPUT FMT	1						
R HFSEL	0						
R BITMAP SEL	0	1	2	0	3	0	1
default V-by-One®HS Byte Mode	3	3	3	3	3	4	4
Format Name Vx1HS std. Packer Packet ref.	YUV422 Map1	YUV422 Map2	YUV422 Map3	RAW8	RAW8 Map4	YUV422HF Map1	YUV422HF Map2
V-by-One®HS D[31]	-	-	-	-	-	Y[7](1st)	Cb(U)[7]
V-by-One®HS D[30]	-	-	-	-	-	Y[6](1st)	Cb(U)[6]
V-by-One®HS D[29]	-	-	-	-	-	Y[5](1st)	Cb(U)[5]
V-by-One®HS D[28]	-	-	-	-	-	Y[4](1st)	Cb(U)[4]
V-by-One®HS D[27]	-	-	-	-	-	Y[3](1st)	Cb(U)[3]
V-by-One®HS D[26]	-	-	-	-	-	Y[2](1st)	Cb(U)[2]
V-by-One®HS D[25]	-	-	-	-	-	Y[1](1st)	Cb(U)[1]
V-by-One®HS D[24]	-	-	-	-	-	Y[0](1st)	Cb(U)[0]
V-by-One®HS D[23]	Cb(U)[7]/Cr(V)[7]	Y[7](1st)/Y[7](2nd)	0	RAW[7] (1st)	RAW[7] (1st)	Cb(U)[7]	Y[7](1st)
V-by-One®HS D[22]	Cb(U)[6]/Cr(V)[6]	Y[6](1st)/Y[6](2nd)	0	RAW[6] (1st)	RAW[6] (1st)	Cb(U)[6]	Y[6](1st)
V-by-One®HS D[21]	Cb(U)[5]/Cr(V)[5]	Y[5](1st)/Y[5](2nd)	0	RAW[5] (1st)	RAW[5] (1st)	Cb(U)[5]	Y[5](1st)
V-by-One®HS D[20]	Cb(U)[4]/Cr(V)[4]	Y[4](1st)/Y[4](2nd)	0	RAW[4] (1st)	RAW[4] (1st)	Cb(U)[4]	Y[4](1st)
V-by-One®HS D[19]	Cb(U)[3]/Cr(V)[3]	Y[3](1st)/Y[3](2nd)	0	RAW[3] (1st)	RAW[3] (1st)	Cb(U)[3]	Y[3](1st)
V-by-One®HS D[18]	Cb(U)[2]/Cr(V)[2]	Y[2](1st)/Y[2](2nd)	0	RAW[2] (1st)	RAW[2] (1st)	Cb(U)[2]	Y[2](1st)
V-by-One®HS D[17]	Cb(U)[1]/Cr(V)[1]	Y[1](1st)/Y[1](2nd)	0	RAW[1] (1st)	RAW[1] (1st)	Cb(U)[1]	Y[1](1st)
V-by-One®HS D[16]	Cb(U)[0]/Cr(V)[0]	Y[0](1st)/Y[0](2nd)	0	RAW[0] (1st)	RAW[0] (1st)	Cb(U)[0]	Y[0](1st)
V-by-One®HS D[15]	0	0	Y[7](1st)/Y[7](2nd)	0	0	Y[7](2nd)	Cr(V)[7]
V-by-One®HS D[14]	0	0	Y[6](1st)/Y[6](2nd)	0	0	Y[6](2nd)	Cr(V)[6]
V-by-One®HS D[13]	0	0	Y[5](1st)/Y[5](2nd)	0	0	Y[5](2nd)	Cr(V)[5]
V-by-One®HS D[12]	0	0	Y[4](1st)/Y[4](2nd)	0	0	Y[4](2nd)	Cr(V)[4]
V-by-One®HS D[11]	0	0	Y[3](1st)/Y[3](2nd)	0	RAW[7] (2nd)	Y[3](2nd)	Cr(V)[3]
V-by-One®HS D[10]	0	0	Y[2](1st)/Y[2](2nd)	0	RAW[6] (2nd)	Y[2](2nd)	Cr(V)[2]
V-by-One®HS D[9]	0	0	Y[1](1st)/Y[1](2nd)	0	RAW[5] (2nd)	Y[1](2nd)	Cr(V)[1]
V-by-One®HS D[8]	0	0	Y[0](1st)/Y[0](2nd)	0	RAW[4] (2nd)	Y[0](2nd)	Cr(V)[0]
V-by-One®HS D[7]	Y[7](1st)/Y[7](2nd)	Cb(U)[7]/Cr(V)[7]	Cb(U)[7]/Cr(V)[7]	RAW[7] (2nd)	RAW[3] (2nd)	Cr(V)[7]	Y[7](2nd)
V-by-One®HS D[6]	Y[6](1st)/Y[6](2nd)	Cb(U)[6]/Cr(V)[6]	Cb(U)[6]/Cr(V)[6]	RAW[6] (2nd)	RAW[2] (2nd)	Cr(V)[6]	Y[6](2nd)
V-by-One®HS D[5]	Y[5](1st)/Y[5](2nd)	Cb(U)[5]/Cr(V)[5]	Cb(U)[5]/Cr(V)[5]	RAW[5] (2nd)	RAW[1] (2nd)	Cr(V)[5]	Y[5](2nd)
V-by-One®HS D[4]	Y[4](1st)/Y[4](2nd)	Cb(U)[4]/Cr(V)[4]	Cb(U)[4]/Cr(V)[4]	RAW[4] (2nd)	RAW[0] (2nd)	Cr(V)[4]	Y[4](2nd)
V-by-One®HS D[3]	Y[3](1st)/Y[3](2nd)	Cb(U)[3]/Cr(V)[3]	Cb(U)[3]/Cr(V)[3]	RAW[3] (2nd)	0	Cr(V)[3]	Y[3](2nd)
V-by-One®HS D[2]	Y[2](1st)/Y[2](2nd)	Cb(U)[2]/Cr(V)[2]	Cb(U)[2]/Cr(V)[2]	RAW[2] (2nd)	0	Cr(V)[2]	Y[2](2nd)
V-by-One®HS D[1]	Y[1](1st)/Y[1](2nd)	Cb(U)[1]/Cr(V)[1]	Cb(U)[1]/Cr(V)[1]	RAW[1] (2nd)	0	Cr(V)[1]	Y[1](2nd)
V-by-One®HS D[0]	Y[0](1st)/Y[0](2nd)	Cb(U)[0]/Cr(V)[0]	Cb(U)[0]/Cr(V)[0]	RAW[0] (2nd)	0	Cr(V)[0]	Y[0](2nd)

Table 5. V-by-One® HS output data mapping format 2/3

R_OUTPUT_FMT	1	2	3	4	5	6	7
R_HFSEL	1	-	0	1	0	1	1
R_BITMAP_SEL	2	-	0	0	0	0	2
default V-by-One®HS Byte Mode	4	3	3	4	3	4	4
Format Name Vx1HS std. Packer Packet ref.	RAW8HF	RGB888	RGB565	RGB565HF	RAW10	RAW10HF Map1	RAW10HF Map3
V-by-One®HS D[31]	RAW[7] (2nd)	-	-	B[4] (1st)	-	0	0
V-by-One®HS D[30]	RAW[6] (2nd)	-	-	B[3] (1st)	-	0	0
V-by-One®HS D[29]	RAW[5] (2nd)	-	-	B[2] (1st)	-	0	0
V-by-One®HS D[28]	RAW[4] (2nd)	-	-	B[1] (1st)	-	0	0
V-by-One®HS D[27]	RAW[3] (2nd)	-	-	B[0] (1st)	-	0	RAW[9] (1st)
V-by-One®HS D[26]	RAW[2] (2nd)	-	-	G[5] (1st)	-	0	RAW[8] (1st)
V-by-One®HS D[25]	RAW[1] (2nd)	-	-	G[4] (1st)	-	RAW[1] (1st)	RAW[7] (1st)
V-by-One®HS D[24]	RAW[0] (2nd)	-	-	G[3] (1st)	-	RAW[0] (1st)	RAW[6] (1st)
V-by-One®HS D[23]	RAW[7] (1st)	B[7]	B[4]	G[2] (1st)	0	RAW[9] (1st)	RAW[5] (1st)
V-by-One®HS D[22]	RAW[6] (1st)	B[6]	B[3]	G[1] (1st)	0	RAW[8] (1st)	RAW[4] (1st)
V-by-One®HS D[21]	RAW[5] (1st)	B[5]	B[2]	G[0] (1st)	0	RAW[7] (1st)	RAW[3] (1st)
V-by-One®HS D[20]	RAW[4] (1st)	B[4]	B[1]	R[4] (1st)	0	RAW[6] (1st)	RAW[2] (1st)
V-by-One®HS D[19]	RAW[3] (1st)	B[3]	B[0]	R[3] (1st)	0	RAW[5] (1st)	RAW[1] (1st)
V-by-One®HS D[18]	RAW[2] (1st)	B[2]	0	R[2] (1st)	0	RAW[4] (1st)	RAW[0] (1st)
V-by-One®HS D[17]	RAW[1] (1st)	B[1]	0	R[1] (1st)	0	RAW[3] (1st)	0
V-by-One®HS D[16]	RAW[0] (1st)	B[0]	0	R[0] (1st)	0	RAW[2] (1st)	0
V-by-One®HS D[15]	RAW[7] (4th)	G[7]	G[5]	B[4] (2nd)	0	0	0
V-by-One®HS D[14]	RAW[6] (4th)	G[6]	G[4]	B[3] (2nd)	0	0	0
V-by-One®HS D[13]	RAW[5] (4th)	G[5]	G[3]	B[2] (2nd)	0	0	0
V-by-One®HS D[12]	RAW[4] (4th)	G[4]	G[2]	B[1] (2nd)	0	0	0
V-by-One®HS D[11]	RAW[3] (4th)	G[3]	G[1]	B[0] (2nd)	0	0	RAW[9] (2nd)
V-by-One®HS D[10]	RAW[2] (4th)	G[2]	G[0]	G[5] (2nd)	0	0	RAW[8] (2nd)
V-by-One®HS D[9]	RAW[1] (4th)	G[1]	0	G[4] (2nd)	RAW[1]	RAW[1] (2nd)	RAW[7] (2nd)
V-by-One®HS D[8]	RAW[0] (4th)	G[0]	0	G[3] (2nd)	RAW[0]	RAW[0] (2nd)	RAW[6] (2nd)
V-by-One®HS D[7]	RAW[7] (3rd)	R[7]	R[4]	G[2] (2nd)	RAW[9]	RAW[9] (2nd)	RAW[5] (2nd)
V-by-One®HS D[6]	RAW[6] (3rd)	R[6]	R[3]	G[1] (2nd)	RAW[8]	RAW[8] (2nd)	RAW[4] (2nd)
V-by-One®HS D[5]	RAW[5] (3rd)	R[5]	R[2]	G[0] (2nd)	RAW[7]	RAW[7] (2nd)	RAW[3] (2nd)
V-by-One®HS D[4]	RAW[4] (3rd)	R[4]	R[1]	R[4] (2nd)	RAW[6]	RAW[6] (2nd)	RAW[2] (2nd)
V-by-One®HS D[3]	RAW[3] (3rd)	R[3]	R[0]	R[3] (2nd)	RAW[5]	RAW[5] (2nd)	RAW[1] (2nd)
V-by-One®HS D[2]	RAW[2] (3rd)	R[2]	0	R[2] (2nd)	RAW[4]	RAW[4] (2nd)	RAW[0] (2nd)
V-by-One®HS D[1]	RAW[1] (3rd)	R[1]	0	R[1] (2nd)	RAW[3]	RAW[3] (2nd)	0
V-by-One®HS D[0]	RAW[0] (3rd)	R[0]	0	R[0] (2nd)	RAW[2]	RAW[2] (2nd)	0

Table 6. V-by-One® HS output data mapping format 3/3

R OUTPUT_FMT	5	1	1	6	7	7	7
R_HFSEL	0	1	1	-	-	-	-
R_BITMAP_SEL	0	0	1	0	2	0	1
default V-by-One®HS Byte Mode	3	4	4	3	3	3	3
Format Name Vx1HS std. Packer Packet ref.	RAW12	RAW12HF Map1	RAW12HF Map2	RAW10HF2 Map1	RAW10HF2 Map3	RAW12HF2 Map1	RAW12HF2 Map2
V-by-One®HS D[31]	-	0	0	-	-	-	-
V-by-One®HS D[30]	-	0	0	-	-	-	-
V-by-One®HS D[29]	-	0	0	-	-	-	-
V-by-One®HS D[28]	-	0	0	-	-	-	-
V-by-One®HS D[27]	-	RAW[3] (1st)	RAW[11] (1st)	-	-	-	-
V-by-One®HS D[26]	-	RAW[2] (1st)	RAW[10] (1st)	-	-	-	-
V-by-One®HS D[25]	-	RAW[1] (1st)	RAW[9] (1st)	-	-	-	-
V-by-One®HS D[24]	-	RAW[0] (1st)	RAW[8] (1st)	-	-	-	-
V-by-One®HS D[23]	0	RAW[11] (1st)	RAW[7] (1st)	0	RAW[9] (1st)	RAW[3] (1st)	RAW[11] (1st)
V-by-One®HS D[22]	0	RAW[10] (1st)	RAW[6] (1st)	0	RAW[8] (1st)	RAW[2] (1st)	RAW[10] (1st)
V-by-One®HS D[21]	0	RAW[9] (1st)	RAW[5] (1st)	RAW[1] (1st)	RAW[7] (1st)	RAW[1] (1st)	RAW[9] (1st)
V-by-One®HS D[20]	0	RAW[8] (1st)	RAW[4] (1st)	RAW[0] (1st)	RAW[6] (1st)	RAW[0] (1st)	RAW[8] (1st)
V-by-One®HS D[19]	0	RAW[7] (1st)	RAW[3] (1st)	RAW[9] (1st)	RAW[5] (1st)	RAW[11] (1st)	RAW[7] (1st)
V-by-One®HS D[18]	0	RAW[6] (1st)	RAW[2] (1st)	RAW[8] (1st)	RAW[4] (1st)	RAW[10] (1st)	RAW[6] (1st)
V-by-One®HS D[17]	0	RAW[5] (1st)	RAW[1] (1st)	RAW[7] (1st)	RAW[3] (1st)	RAW[9] (1st)	RAW[5] (1st)
V-by-One®HS D[16]	0	RAW[4] (1st)	RAW[0] (1st)	RAW[6] (1st)	RAW[2] (1st)	RAW[8] (1st)	RAW[4] (1st)
V-by-One®HS D[15]	0	0	0	RAW[5] (1st)	RAW[1] (1st)	RAW[7] (1st)	RAW[3] (1st)
V-by-One®HS D[14]	0	0	0	RAW[4] (1st)	RAW[0] (1st)	RAW[6] (1st)	RAW[2] (1st)
V-by-One®HS D[13]	0	0	0	RAW[3] (1st)	0	RAW[5] (1st)	RAW[1] (1st)
V-by-One®HS D[12]	0	0	0	RAW[2] (1st)	0	RAW[4] (1st)	RAW[0] (1st)
V-by-One®HS D[11]	RAW[3]	RAW[3] (2nd)	RAW[11] (2nd)	0	RAW[9] (2nd)	RAW[3] (2nd)	RAW[11] (2nd)
V-by-One®HS D[10]	RAW[2]	RAW[2] (2nd)	RAW[10] (2nd)	0	RAW[8] (2nd)	RAW[2] (2nd)	RAW[10] (2nd)
V-by-One®HS D[9]	RAW[1]	RAW[1] (2nd)	RAW[9] (2nd)	RAW[1] (2nd)	RAW[7] (2nd)	RAW[1] (2nd)	RAW[9] (2nd)
V-by-One®HS D[8]	RAW[0]	RAW[0] (2nd)	RAW[8] (2nd)	RAW[0] (2nd)	RAW[6] (2nd)	RAW[0] (2nd)	RAW[8] (2nd)
V-by-One®HS D[7]	RAW[11]	RAW[11] (2nd)	RAW[7] (2nd)	RAW[9] (2nd)	RAW[5] (2nd)	RAW[11] (2nd)	RAW[7] (2nd)
V-by-One®HS D[6]	RAW[10]	RAW[10] (2nd)	RAW[6] (2nd)	RAW[8] (2nd)	RAW[4] (2nd)	RAW[10] (2nd)	RAW[6] (2nd)
V-by-One®HS D[5]	RAW[9]	RAW[9] (2nd)	RAW[5] (2nd)	RAW[7] (2nd)	RAW[3] (2nd)	RAW[9] (2nd)	RAW[5] (2nd)
V-by-One®HS D[4]	RAW[8]	RAW[8] (2nd)	RAW[4] (2nd)	RAW[6] (2nd)	RAW[2] (2nd)	RAW[8] (2nd)	RAW[4] (2nd)
V-by-One®HS D[3]	RAW[7]	RAW[7] (2nd)	RAW[3] (2nd)	RAW[5] (2nd)	RAW[1] (2nd)	RAW[7] (2nd)	RAW[3] (2nd)
V-by-One®HS D[2]	RAW[6]	RAW[6] (2nd)	RAW[2] (2nd)	RAW[4] (2nd)	RAW[0] (2nd)	RAW[6] (2nd)	RAW[2] (2nd)
V-by-One®HS D[1]	RAW[5]	RAW[5] (2nd)	RAW[1] (2nd)	RAW[3] (2nd)	0	RAW[5] (2nd)	RAW[1] (2nd)
V-by-One®HS D[0]	RAW[4]	RAW[4] (2nd)	RAW[0] (2nd)	RAW[2] (2nd)	0	RAW[4] (2nd)	RAW[0] (2nd)

6.5.3 V-by-One® HS output Byte mode

Setting of V-by-One® HS output Byte mode follows format setting or register control.

When V-by-One® HS Self Pattern Generator (BIST) is active, R_BISTEN=1: Enable, Byte mode is 3Byte fixed.

Table 7. V-by-One® HS output Byte mode setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1036	[0]	R_COL_SEL	1	R/W	V-by-One® HS COL (COLor depth) Byte mode setting method 0: AUTO (COL_FMT defined by output format setting) 1: Manual (R_COL_MAN)	1'h0
0x1037	[5:4]	R_COL_MAN[1:0]	2	R/W	V-by-One® HS Manual Color Depth Select 00 : Reserved 01 : 8bit (3Byte mode) 10 : 10bit (4Byte mode) 11 : Reserved	2'h2

6.5.4 V-by-One® HS Low Radiation Emission or High Immunity Resistance mode

V-by-One® HS Low Radiation Emission and High Immunity Resistance mode are available.

Immunity resistance strength is HS (2'b11) > HS (2'b10).

Radiated emission level is HS (2'b11) > HS (2'b10).

Table 8. V-by-One® HS Low Radiation Emission or High Immunity Resistance mode setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x101B	[5:4]	R_NHSEL	2	R/W	V-by-One® HS setting 00 : Reserved 01 : Reserved 10 : V-by-One® HS standard Low Radiation Emission mode 11 : V-by-One® HS standard High Immunity Resistance mode	2'h3

6.5.5 V-by-One® HS output Drivability

V-by-One® HS driver emphasis and strength controls are adjustable.

Table 9. V-by-One® HS output Drivability setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1020	[7:6]	R_ML0_PRE	2	R/W	V-by-One® HS lane0 Pre-Emphasis when R_ML0_DRV=00 00 : 0% 01 : 50% 10 : 100% 11 : not allowed when R_ML0_DRV=01 00 : 0% 01 : 50% 10/11 : not allowed when R_ML0_DRV=10 00 : 0% 01/10/11 : not allowed	2'h0
0x1020	[3:2]	R_ML0_DRV	2	R/W	V-by-One® HS lane0 Drive Strength Select 00: VTOD=200mV 01: VTOD=300mV 10: VTOD=400mV	2'h2

6.5.6 V-by-One® HS output Low Frequency mode

V-by-One® HS Low Frequency Mode is available. For usage of Low Frequency mode, counterpart V-by-One® receiver must have installed Low Frequency mode format decoder like THCV236.

Table 10. V-by-One® HS Low Frequency Mode setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x101B	[0]	R_LFQEN	1	R/W	V-by-One® HS Low FreqModeEnable 0:Normal 1:Low Frequency Mode	1'h0

6.5.7 Target Pixel clock

Target pixel clock for transmission is defined by a formula below.

Relationship between used packet and byte mode packet transfer potential is determined by output format (from Table 4) and whether Auto or Manual Byte-mode setting is used or not in Byte-mode setting (Table 7).

[dmp] = MIPI Data-rate

[nmp] = MIPI lane number

[bmvx1] = V-by-One® HS Byte Mode

[PCLK.target] = Pixel clock target for V-by-One® HS per lane = [F(target)]

Total pixel data-rate = [dmp] x [nmp]

$$= [\text{PCLK.target}] \times [\text{bmvx1}] \times 8 \times \frac{\text{Used packet in output format}}{\text{Byte mode packet total}}$$

$$[\text{PCLK.target}] = \frac{[\text{dmp}] \times [\text{nmp}]}{[\text{bmvx1}] \times 8 \times \frac{\text{Used packet in output format}}{\text{Byte mode packet total}}} = [\text{F(target)}]$$

6.6 Blanking period restriction under low MIPI data-rate environment

First of all, horizontal blanking period must meet minimum required length as MIPI standard defines to change MIPI data lane from Low Power mode to High Speed mode and from High Speed mode to Low Power mode.

In addition for THCV243, when MIPI data-rate per lane is slower than 160Mbps, horizontal blanking period length must meet below rule.

$$\text{Horizontal blanking period (@[dmp]<160Mbps)} > \frac{168}{[\text{dmp}]}$$

Another alternative is simply to use 160Mbps and higher MIPI data-rate because cases to use below 160Mbps must be the cases of [nmp]=4 so that MIPI data-rate can be arranged to be higher by using [nmp]=1 or 2 configuration.

6.7 PLL setting

PLL setting is required. For manual setting, R_PLL_SET_MODE is supposed to be set 1 (Manual mode) from default value 0. PLL Manual mode setting set R_PLL_SETTING[47:0] is related with CKI frequency.

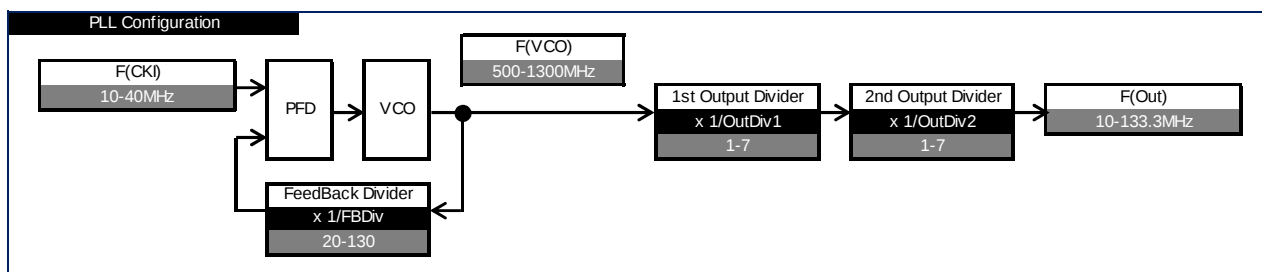


Figure 5. Reference clock supply basic method

PLL_SETTING[47:0] must be selected proper to meet below constraints.

Table 11. PLL constraints table

symbol	discription	condition	min	typ	max	unit
F(CKI)	CKI input frequency	-	10	-	40	MHz
FBDiv	FeedBack Divider value	-	20	-	130	-
OutDiv1	1st Output Divider value (OutDiv1 must be >= OutDiv2)	-	1	-	7	-
OutDiv2	2nd Output Divider value (OutDiv1 must be >= OutDiv2)	-	1	-	7	-
F(VCO)	VCO frequency	-	500	-	1300	MHz
F(OUT)	PLL output pixel clock frequency	-	10	-	133.3	MHz
ΔF	Allowed error between F(target) vs F(OUT)	Hactive=< 1280pixels and [dmp]x[nmp] < 500Mbps	R_SPREAD	-	8	%
		1280 <Hactive=< 1920pixels and [dmp]x[nmp] < 800Mbps				
		1920 <Hactive=< 3840pixels and [dmp]x[nmp] <1500Mbps				
		otherwise	0	0	8	%

Pixel clock frequency made by PLL is calculated as below.

$$[\text{PCLK.actual}] = \text{Pixel clock actually used for V-by-One® HS per lane} = [\text{F(OUT)}]$$

$$[\text{PCLK.actual}] = [\text{F(OUT)}] = \frac{[\text{F(CKI)}] \times [\text{FBDiv}]}{[\text{OutDiv1}] \times [\text{OutDiv2}]}$$

Actual Pixel clock, F(OUT) frequency must be equal or greater than ideal target Pixel clock, F(target) by 8% accuracy as below formula for most cases.

$$[\text{F(target)}] \leq [\text{F(OUT)}] \leq [\text{F(target)}] \times \frac{108}{100}$$

When transmitted camera image format horizontal active is rather large and total pixel data-rate is rather slow as described in previous table condition, minimum allowed F(OUT) setting is not equal to F(target) if Spread Spectrum function is activated. ΔF is supposed to be more than absolute value of applied SSCG modulation rate, $|R_SPREAD|$, under the condition specified on PLL constraints table.

$$\Delta F = \frac{[F(OUT)] - [F(target)]}{[F(target)]}$$

Table 12. PLL setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x100F	[0]	R_PLL_SET_MODE	1	R/W	PLL setting mode 0:PLL Auto setting mode 1:PLL Manual setting mode	1'h0
0x1011	[7:0]	R_PLL_SETTING[47:40]	8	R/W	PLL setting value, Feedback Divider value (integer part)	8'h00
0x1012	[7:0]	R_PLL_SETTING[39:32]	8	R/W	PLL setting value, Feedback Divider value (decimal part MSB)	8'h00
0x1013	[7:0]	R_PLL_SETTING[31:24]	8	R/W	PLL setting value, Feedback Divider value (decimal part)	8'h00
0x1014	[7:0]	R_PLL_SETTING[23:16]	8	R/W	PLL setting value, Feedback Divider value (decimal part LSB)	8'h00
0x1015	[7]	R_PLL_SETTING[15]	1	R/W	PLL setting value	1'h0
0x1015	[6:4]	R_PLL_SETTING[14:12]	3	R/W	PLL setting value, OutDiv1 (OutDiv1 must be >= OutDiv2)	3'h0
0x1015	[3]	R_PLL_SETTING[11]	1	R/W	PLL setting value	1'h0
0x1015	[2:0]	R_PLL_SETTING[10:8]	3	R/W	PLL setting value, OutDiv2 (OutDiv1 must be >= OutDiv2)	3'h0
0x1016	[7:0]	R_PLL_SETTING[7:0]	8	R/W	PLL setting value, Reserved (must be set to 8'h01)	8'h00

Below Table 13 is Look Up Table for typical cases.

Table 13. PLL setting Look Up Table

index	condition	input	output	f_CK1 (MHz)	PLL[47:40]	PLL[39:32]	PLL[31:24]	PLL[23:16]	PLL[15:8]	PLL[7:0]
1	720p30fps RAW	594Mbps x1lane	MPRF	27	0x18	0xC0	0x00	0x00	0x66	0x01
2				37.125	0x15	0x00	0x00	0x00	0x76	0x01
3	720p30fps YUV422	600Mbps x1lane	MPRF	24	0x1C	0x20	0x00	0x00	0x66	0x01
4	720p60fps RAW	445.5Mbps x2lane	MPRF	27	0x25	0x20	0x00	0x00	0x66	0x01
5	1080p30fps RAW			37.125	0x1B	0x00	0x00	0x00	0x66	0x01
6	720p60fps YUV422			27	0x21	0x00	0x00	0x00	0x64	0x01
7	1080p30fps YUV422	594Mbps x2lane	MPRF	37.125	0x18	0x00	0x00	0x00	0x64	0x01
8	720p120fps RAW	891Mbps x2lane	MPRF	27	0x21	0x00	0x00	0x00	0x44	0x01
9	1080p60fps RAW			37.125	0x18	0x00	0x00	0x00	0x44	0x01
10	720p120fps YUV422	594Mbps x4lane	MPRF	27	0x2C	0x00	0x00	0x00	0x44	0x01
11	1080p60fps YUV422			37.125	0x20	0x00	0x00	0x00	0x44	0x01
15				27	0x21	0x00	0x00	0x00	0x66	0x01
16	720p30fps RAW	594Mbps x1lane	RAW12HF Map2	37.125	0x18	0x00	0x00	0x00	0x66	0x01
17	720p30fps YUV422	600Mbps x1lane	YUV422 Map1(4Byte) forced 4Byte	24	0x19	0x00	0x00	0x00	0x44	0x01
18	720p60fps RAW	445.5Mbps x2lane	RAW12HF Map2	27	0x21	0x00	0x00	0x00	0x64	0x01
19	1080p30fps RAW			37.125	0x18	0x00	0x00	0x00	0x64	0x01
20	720p60fps YUV422			27	0x2C	0x00	0x00	0x00	0x44	0x01
21	1080p30fps YUV422	594Mbps x2lane	YUV422 Map1(4Byte) forced 4Byte	37.125	0x20	0x00	0x00	0x00	0x44	0x01
22	720p120fps RAW	891Mbps x2lane	RAW12HF Map2	27	0x2C	0x00	0x00	0x00	0x44	0x01
23	1080p60fps RAW			37.125	0x20	0x00	0x00	0x00	0x44	0x01
24	720p120fps YUV422			27	0x2C	0x00	0x00	0x00	0x44	0x01
25	1080p60fps YUV422	594Mbps x4lane	YUV422HF Map1	37.125	0x20	0x00	0x00	0x00	0x44	0x01

6.8 PLL Auto setting function

PLL auto setting function is available in case all the following conditions are met.

- ✓ V-by-One® HS output format setting (Address 0x1001) is MPRF.
- ✓ F(CKI) is 37.125MHz or 27MHz or 24MHz.
- ✓ MIPI input data-rate is equal to the integral multiple of F(CKI)

Under PLL auto setting function operation, it is sufficient only to control below resistors. No control on R_PLL_SETTING[47:0] is required.

Table 14. PLL Auto setting function control Resistors

Addr(h)	Bits	Register	width	R/W	Description	Default
0x100F	[0]	R_PLL_SET_MODE	1	R/W	PLL setting mode 0:PLL Auto setting mode 1:PLL Manual setting mode	1'h0
0x100E	[7:6]	R_CK1_FREQ	2	R/W	PLL Auto setting input frequency choice 2'h0: Reserved 2'h1: 37.125MHz 2'h2: 27MHz 2'h3: 24MHz	2'h0
0x100E	[5:0]	R_MIPI_MULT	6	R/W	PLL Auto setting multiplying ratio MIPI data-rate vs. F(CKI) Below formula must be met to application condition. MIPI Data-rate = F(CKI) *(R_MIPI_MULT+1)	6'hF
0x1001	[6:4]	R_OUTPUT_FMT	3	R/W	Setting value 000:MPRF is required for PLL Auto setting function. See other Table for detail description	3'h0
0x1002	[5]	R_HFSEL	1	R/W	See other Table for detail description	1'h0
0x102D	[1:0]	R_RX_LANE_SEL_EN	2	R/W	See other Table for detail description	2'h3

If above PLL Auto setting control values are invalid and unmatched to application condition, C_PLL_SET_NG indicator is asserted.

Table 15. PLL Auto setting control invalid Indicator

Addr(h)	Bits	Register	width	R/W	Description	Default
0x112F	[0]	C_PLL_SET_NG	1	R	PLL Auto Setting control invalid indicator 0: PLL Auto Setting control valid or PLL Manual setting mode 1: PLL Auto Setting control invalid	-

6.9 V-by-One® HS output data-rate

V-by-One® HS output data-rate is made of actual Pixel clock frequency.

$$\text{V-by-One® HS physical Data-rate} = [\text{PCLK.actual}] \times [\text{bmvx1}] \times 8 \times \frac{10}{8}$$

At Low Frequency Mode, Data-rate is doubled.

$$\text{V-by-One® HS physical Data-rate on LowFreq.Mode} = [\text{PCLK.actual}] \times [\text{bmvx1}] \times 8 \times \frac{10}{8} \times 2$$

Supported Data-rate is from 400Mbps to 4Gbps.

6.10 V-by-One® HS output Spread Spectrum

Spread Spectrum Clock Generation (SSCG) modulation is available to apply on V-by-One® HS output.

$$[\text{PCLK.actual}] \big|_{\text{no SSCG}} \times \frac{(100 - |\text{R_SPREAD}|)}{100} < [\text{PCLK.actual}] \big|_{\text{SSCG}} < [\text{PCLK.actual}] \big|_{\text{no SSCG}} \times \frac{(100 + |\text{R_SPREAD}|)}{100}$$

Table 16. V-by-One® HS output Spread Spectrum settings

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1010	[7:4]	R_DIVVAL	4	R/W	SSCG modulation frequency setting fmod = F(CKI) / (128*R_DIVVAL)	4'h0
0x1019	[3:0]	R_SPREAD	4	R/W	SSCG modulation rate setting 4'h0 : modulation rate =0, 4'h1 : modulation rate =+/-0.1%, 4'h2 : modulation rate =+/-0.2%, ..., 4'h5 : modulation rate =+/-0.5%, ..., 4'hF : modulation rate =+/-1.5%	4'h3
0x101A	[0]	R_DISABLE_SSCG	1	R/W	SSCG modulation Enable/Disable setting 0:Enable 1:Disable	1'h1

SSCG modulation frequency divider setting values, R_DIVVAL on Address 0x1010, to meet V-by-One® HS standard 30kHz +/-0.5% are exemplified below.

Table 17. V-by-One® HS output SSCG R_DIVVAL setting examples

(MHz)	(hex.)	(dec.)	(kHz)
F(CKI)	R_DIVVAL	R_DIVVAL	fmod
37.125	4'hC(0xC)	12	24.2
27	4'h8(0x8)	8	26.4
24	4'h8(0x8)	8	23.4

6.11 V-by-One® HS CRC

V-by-One® HS transmission packet payload fault or error can be detected with CRC. THCV243 generates and sends check value to receiver. For usage of CRC function, the counterpart V-by-One® receiver must have installed CRC monitor like THCV242.

Table 18. V-by-One® HS CRC setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1054	[0]	R_CRC_OFF	1	R/W	V-by-One® HS CRC generator ON/OFF (ON default) 0: CRC output ON 1: CRC output OFF	1'h0

6.12 MIPI Packet Header V-by-One® HS output bridge mode

MIPI PH(Packet Header) can be bridge to V-by-One® HS output following selected schemes.

“R_PHMODE=2'b01” setting on THCV236 connection is only supported where HFSEL=0 setting is applied on THCV236.

Table 19. V-by-One® HS output MIPI Packet Header bridge setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1001	[1:0]	R_PHMODE	2	R/W	V-by-One® HS output MIPI PH(Packet Header) timing setting 00:PH in normal data packet just after DE rise (THCV242 default) 01:PH in CTL packet of blanking period till 1pixel before DE rise 10,11:no PH	2'h0

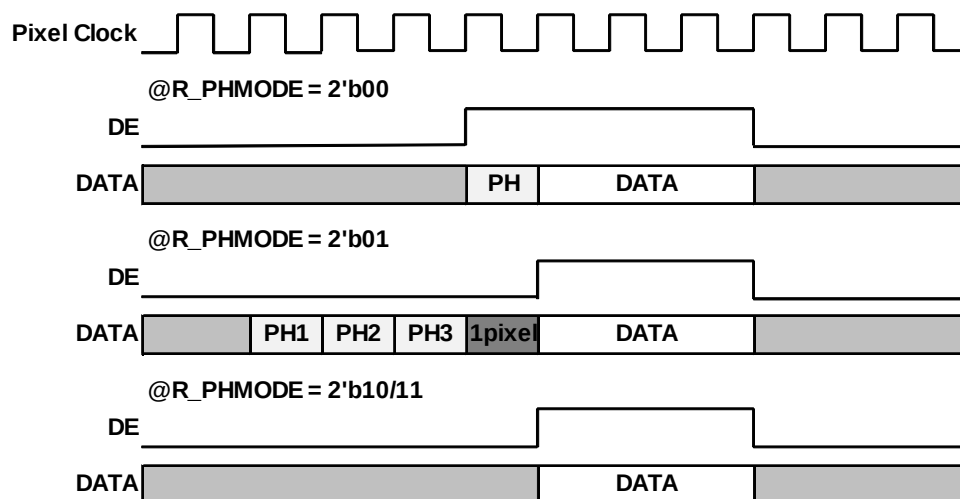


Figure 6. MIPI Packet Header V-by-One® HS output bridge timing alternative

										MIPI PH																															
										0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
										DID7	DID6	DID5	DID4	DID3	DID2	DID1	DID0	WC7	WC6	WC5	WC4	WC3	WC2	WC1	WC0	WC15	WC14	WC13	WC12	WC11	WC10	WC9	WC8	ECC7	ECC6	ECC5	ECC4	ECC3	ECC2	ECC1	ECC0
										Vx1 PH																															
										*CTL packet																															
THCV236		PH		*CTL packet																																					
HFSEL=0		4byte		V-by-One@HS_D[31]*																																					
		3byte		V-by-One@HS_D[30]*																																					
		4byte		V-by-One@HS_D[29]*																																					
		3byte		V-by-One@HS_D[28]*																																					
		4byte		V-by-One@HS_D[27]*																																					
		3byte		V-by-One@HS_D[26]*																																					
		4byte		V-by-One@HS_D[25]*																																					
		3byte		V-by-One@HS_D[24]*																																					
		4byte		V-by-One@HS_D[23]*																																					
		3byte		V-by-One@HS_D[22]*																																					
		4byte		V-by-One@HS_D[21]*																																					
		3byte		V-by-One@HS_D[20]*																																					
		4byte		V-by-One@HS_D[19]*																																					
		3byte		V-by-One@HS_D[18]*																																					
		4byte		V-by-One@HS_D[17]*																																					
		3byte		V-by-One@HS_D[16]*																																					
		4byte		V-by-One@HS_D[15]																																					
		3byte		V-by-One@HS_D[14]																																					
		4byte		V-by-One@HS_D[13]																																					
		3byte		V-by-One@HS_D[12]																																					
		4byte		V-by-One@HS_D[11]																																					
		3byte		V-by-One@HS_D[10]																																					
		4byte		V-by-One@HS_D[9]																																					
		3byte		V-by-One@HS_D[8]																																					
		4byte		V-by-One@HS_D[7]																																					
		3byte		V-by-One@HS_D[6]																																					
		4byte		V-by-One@HS_D[5]																																					
		3byte		V-by-One@HS_D[4]																																					
		4byte		V-by-One@HS_D[3]																																					
		3byte		V-by-One@HS_D[2]																																					
		4byte		V-by-One@HS_D[1]																																					
		3byte		V-by-One@HS_D[0]																																					

Figure 7. MIPI Packet Header V-by-One® HS output bridge bit mapping

6.13 MIPI Virtual Channel bridge

When MIPI PH(Packet Header) is bridged to V-by-One® HS output with described schemes above, MIPI Virtual Channel information in PH is bridged to V-by-One® HS at the same time. Virtual Channel is supported.

6.14 V-by-One® HS VSYNC generation

Setting of V-by-One® HS VSYNC output is configurable by 2-wire access on internal register.

Internally generated VSYNC (R_VS_MODE=1) follows Figure 8.

Table 20. V-by-One® HS output VSYNC setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1002	[3:2]	R_FS_FE_SYNCEN	2	R/W	V-by-One® HS Vsync generation Enable at MIPI FS/FE (active only when R_VS_MODE=0) 00:Vsync pulse at both FS and FE (THCV242 default) 01:Vsync pulse at FS only 10:Vsync pulse at FE only 11:no Vsync pulse at FS nor FE	2'h0
0x1004	[1]	R_VSYNC_POL	1	R/W	V-by-One® HS Vsync polarity 0:High pulse (High active) (THCV242 default) 1:Low pulse (Low active)	1'h0
0x1007	[3]	R_VS_MODE	1	R/W	V-by-One® HS VSYNC output timing mode 0:MIPI FS/FE timing direct use mode (THCV242 default) 1:internally generated timing mode	1'h0
0x1007	[2:0]	R_VS_OFFSET	3	R/W	V-by-One® HS internally generated VSYNC offset offset from FE = calculatedVS-HTOTAL x R_VS_OFFSET	3'h0
0x1008	[7:0]	R_VS_WIDTH_PIX	8	R/W	V-by-One® HS internally generated Htotal setting Generated Htotal:calculatedVS-HTOTAL = R_VS_WIDTH_PIX x 16	8'h00
0x1009	[4:2]	R_VS_WIDTH_LINE	3	R/W	V-by-One® HS internally generated VSYNC pulse width VSYNC pulse width = calculatedVS-HTOTAL x R_VS_WIDTH_LINE	3'h0

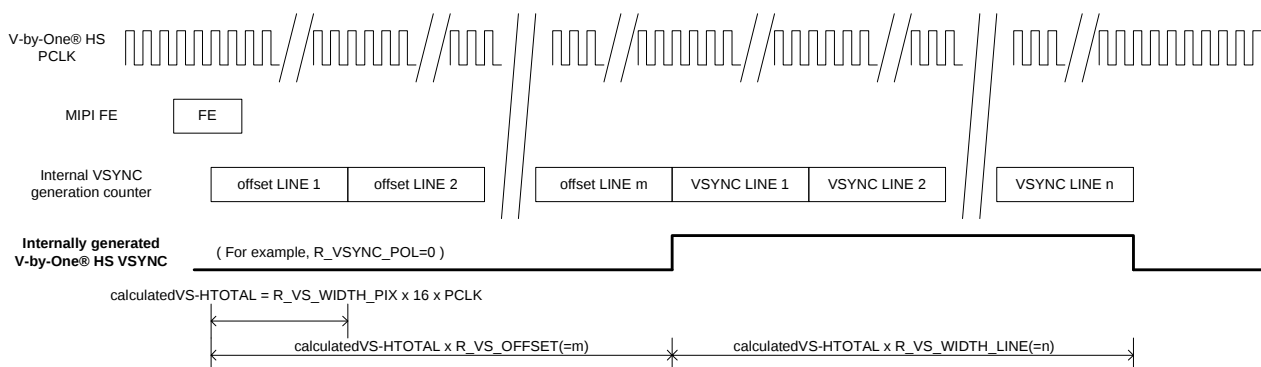


Figure 8. Internally generated VSYNC

6.15 V-by-One® HS HSYNC generation

Setting of V-by-One® HS HSYNC output is configurable by 2-wire access on internal register.

Internally generated HSYNC in Vertical active period (R_HS_MODE=10/11) follows Figure 9.

Internally generated HSYNC in Vertical blanking period (R_HS_VB_EN=10/11) follows Figure 10.

Table 21. V-by-One® HS output HSYNC setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1002	[1:0]	R_LS_LE_SYNCEN	2	R/W	V-by-One® HS Hsync generation Enable at MIPI LS/LE (active only when R_HS_MODE=00, 01) 00:Hsync pulse at both LS and LE (THCV242 default) 01:Hsync pulse at LS only 10:Hsync pulse at LE only 11:no Hsync pulse at LS nor LE	2'h0
0x1004	[0]	R_HSYNC_POL	1	R/W	V-by-One® HS Hsync polarity 0:High pulse (High active) (THCV242 default) 1:Low pulse (Low active)	1'h0
0x1009	[1:0]	R_HS_MODE	2	R/W	V-by-One® HS HSYNC output timing mode 00, 01:MIPI LS/LE timing direct use mode (THCV242 default) 10:internally generated timing mode1 11:internally generated timing mode2	2'h0
0x100A	[4:0]	R_VACT_LINE[12:8]	5	R/W	V-by-One® HS Vactive line skip number MSB	5'h00
0x100B	[7:0]	R_VACT_LINE[7:0]	8	R/W	V-by-One® HS Vactive line skip number LSB	8'h00
0x100C	[1:0]	R_HS_VB_EN	2	R/W	V-by-One® HS HSYNC output in vertical blanking period setting 00, 01:no HSYNC output in Vblank 10:HSYNC output in Vblank, starting from FE 11:HSYNC output in Vblank, starting from FS, skipping Vactive	2'h0
0x100D	[7:0]	R_HS_VB_NUM	8	R/W	V-by-One® HS HSYNC output number in vertical blanking period	8'h00

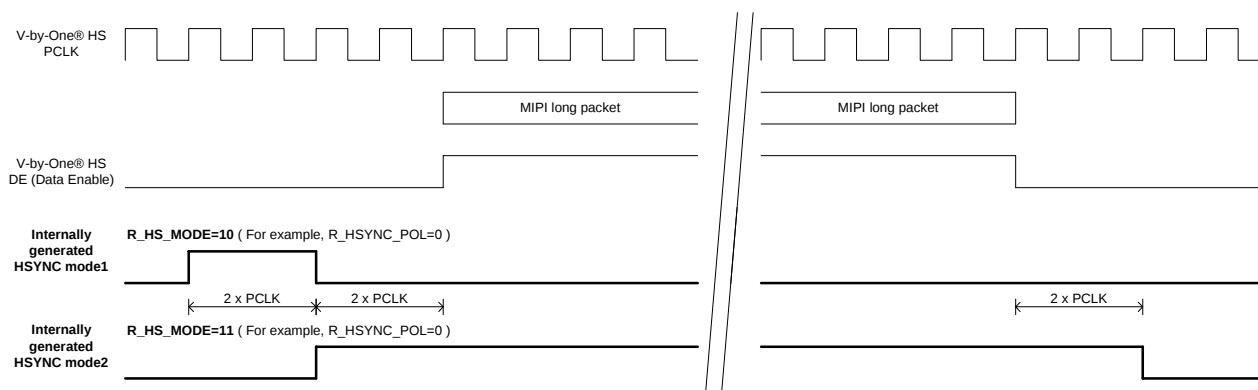


Figure 9. Internally generated HSYNC in Vertical active period

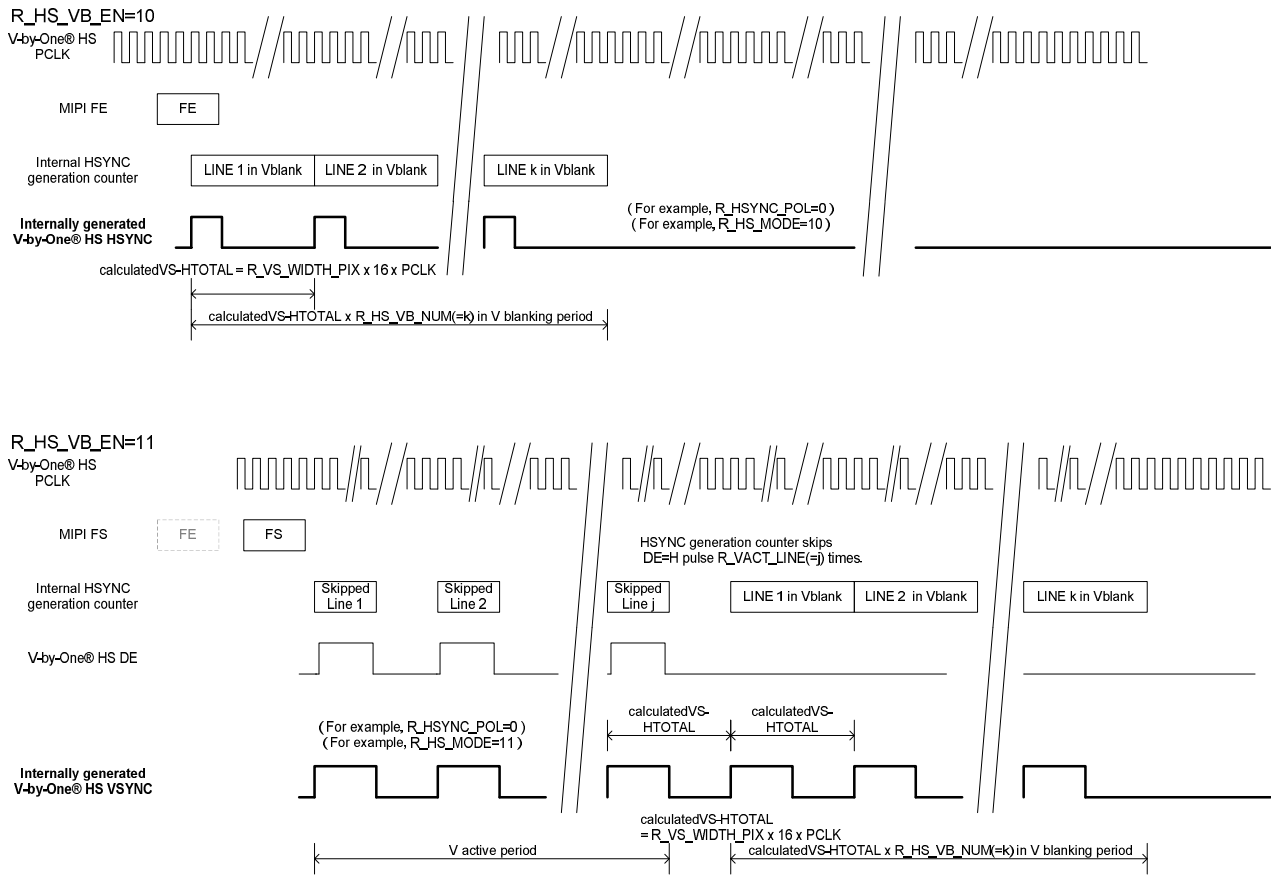


Figure 10. Internally generated HSYNC in Vertical blanking period

6.16 MIPI Short Packet V-by-One® HS output bridge mode

MIPI SP (Short Packet) can be bridge to V-by-One® HS output with the following schemes.

MIPI Short Packet V-by-One® HS output bridge mode is only supported when “R_BITMAP_SEL=2'b00 (MAP1)” or “R_BITMAP_SEL=2'b11 (MAP4)”.

“R_VS_MODE=1'b0” and “R_FS_FE_SYNCEN=2'b00” setting is required to bridge both MIPI Frame Start and Frame End Short Packet. “R_VSYNC_POL=1'b0” setting is required to connect THCV242.

THCV236 connection is only supported where HFSEL=0 setting is applied on THCV236.

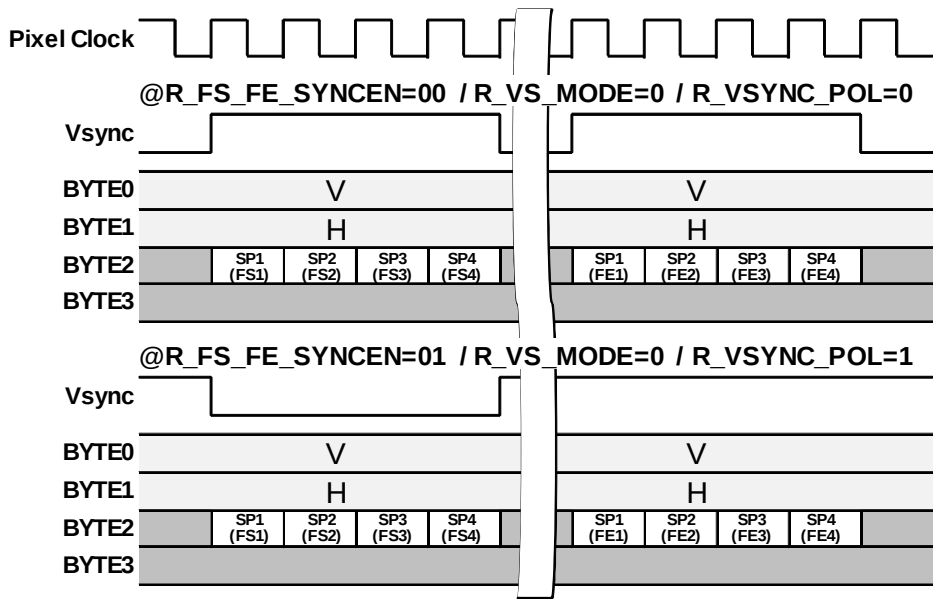


Figure 11. MIPI Short Packet V-by-One® HS bridge timing

[illegible]

6.17 2-wire serial interface

6.17.1 2-wire serial I/F slave Device ID

To use GPIO (General Purpose Input/Output), fault/error detection, and interrupt function, 2-wire serial I/F enables to access registers. AIN pin determines 2-wire slave Device ID setting.

Table 22. 2-wire serial I/F Device ID select by AIN pin

Pin Name	Pin #	type*	Description
AIN	27	I	Select Slave Address 0 : 2wire serial Address = 7'b000_1011 1 : 2wire serial Address = 7'b011_0100

As an additional method, 2-wire slave Device ID setting can be changed from default value by register setting.

Table 23. 2-wire serial I/F Device ID select by register setting

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
Addr(h)	Addr(h)							
0x0050	0x00D0	[7:0]	R_2WIRE_SADR	8	RW	2WIRE slave device address setting [7]2WIRE slave device address control 0: 2WIRE slv device addr. is set by AIN pin 1: 2WIRE slv device addr. is set by following register [6:0] [6:0]2WIRE slave device address value for register control	8'd0	MS

6.17.2 2-wire serial Read/Write access to local Register

HOST MPU can directly access THCV243 local register by 2-wire serial I/F.

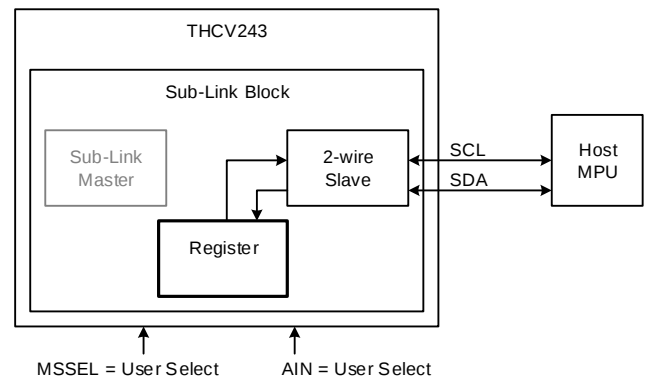


Figure 13. Host to THCV243 local register access configuration

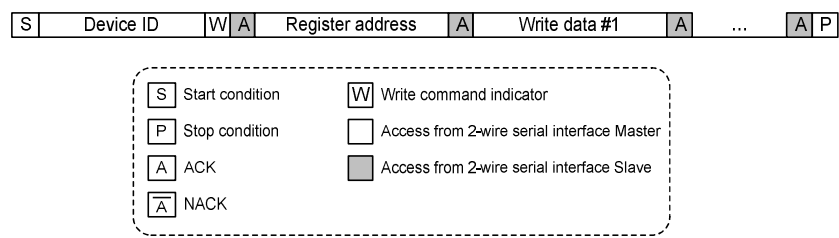


Figure 14. 2-wire serial I/F write to THCV243 local register protocol

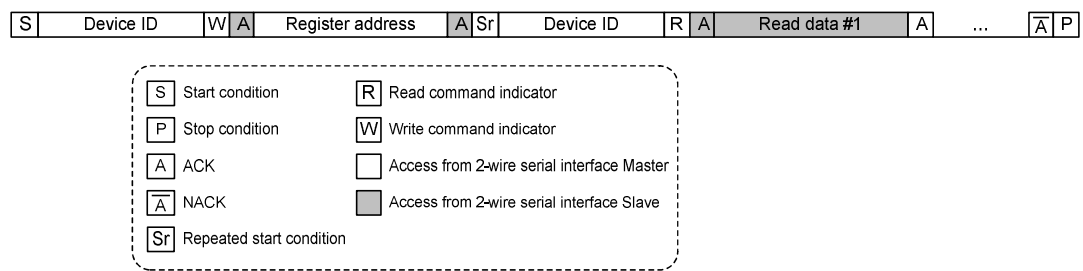


Figure 15. 2-wire serial I/F read to THCV243 local register protocol

6.18 2-wire serial I/F Watch Dog Timer

2-wire Watch Dog Timer (WDT) is installed to monitor status.

Table 24. 2-wire WDT setting

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
Addr(h)	Addr(h)							
0x004B	0x00CB	[4]	R_2WIRE_WD_EN	1	RW	2-wire WDT Enable 0:Disable 1:Enable	1'b1	MS
0x004B	0x00CB	[0]	R_2WIRE_WD_OFFSET	1	RW	2-wire WDT offset time 1:11'd2047 0:11'd1023	1'd1	MS
0x004C	0x00CC	[7:0]	R_2WIRE_WD_TIM	8	RW	2-wire WDT time = $64 \times \{R_2WIRE_WD_TIM<7:0>+1\} \times \{("2WIRE WDT offset time") \times tOSC\}$	8'd255	MS

6.19 Register Auto Checksum diagnosis

Register values checksum is continuously calculated as R_CKSUM_RVAL and checked compared to user-defined target, R_CKSUM_VAL. If any change occurs, it can be reported as interrupt.

Table 25. Register Auto Checksum diagnosis control and monitoring

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
Addr(h)	Addr(h)							
0x0008	0x0088	[0]	R_CKSUM_EN	1	RW	Internal Register AutoCheckSum Enable 0:Disable 1:Enable	1'b0	MS
0x0009	0x0089	[7:0]	R_CKSUM_TIM	8	RW	Internal Register AutoCheckSum check interval $=1024 \times 64 \times (R_CKSUM_TIM<7:0>+1) \times tOSC$	8'd19	MS
0x000A	0x008A	[7:0]	R_CKSUM_VAL	8	RW	Internal Register AutoCheckSum expected target value	8'd0	MS
0x000B	0x008B	[7:0]	R_CKSUM_RVAL	8	R	Internal Register AutoCheckSum read value	-	MS
0x0060	0x00E0	[4]	R_INT_CKSUM_ERR	1	R	Interrupt factor: Internal register Checksum error 1: Interrupt (error is detected)	-	MS
0x0061	0x00E1	[4]	R_INTM_CKSUM_ERR	1	RW	Interrupt mask: Internal register CheckSum error 0: Interrupt mask	1'b0	MS
0x0062	0x00E2	[4]	R_INTC_CKSUM_ERR	1	W	Interrupt clear: Internal register CheckSum error 1: Interrupt clear	-	MS

6.20 Sub-Link setting

Sub-Link Master or Sub-Link Slave operation is selectable by MSSEL pin control.

Sub-Link Master control register address and Sub-Link Slave control register address are different even for the same Sub-Link function register.

Sub-Link Master control register is from 0x0000 to 0x007F.

Sub-Link Slave control register is from 0x0080 to 0x00FF.

As a note, registers other than Sub-Link control register from 0x1000 have only one address for one function, which is independent of Sub-Link operation as Master or Slave.

Sub-Link Master “2-wire Set&Trigger mode1” (R_SLINK_MODE setting) is compatible with THCV236.

Sub-Link Polling interval is controllable from 20us to 800us, that may have relationships on fault/error detection, interrupt, or other UART / GPIO transfer time designed on application. SSR (Sub-Link Status Read) interval determines recovery quickness from 2-wire serial remote communication completion. SSR interval effects only on Sub-Link Master “2-wire Set&Trigger mode1” (R_SLINK_MODE setting).

Table 26. Sub-Link Master protocol basic setting

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master Addr(h)	Slave Addr(h)							
0x0004	-	[1:0]	R_SLINK_MODE	2	RW	Sub-Link basic protocol setting as Sub-Link Master 0: Reserved 1: 2-wire Set&Trigger (Normal) mode1 (compatible with THCV236) 2: Reserved 3: Reserved Note: When this IC is used as Sub-Link Slave, this register setting has no meaning. Counterpart Sub-Link Master setting controls Sub-Link protocol including this IC as slave device.	2'd1	M
0x0010	-	[0]	R_SLINK_EN	1	RW	Sub-link Enable 0:Sublink Disable 1:Sublink Enable	1'b0	M
0x0014	-	[4]	R_SLINK_POL_EN	1	RW	Sublink Polling Enable 0:Disable 1:Enable	1'b1	M
0x0014	-	[1:0]	R_SLINK_POL_TIM_UP	2	RW	Sublink Polling interval setting	2'd0	M
0x0015	-	[7:0]	R_SLINK_POL_TIM_DN	8	RW	Sublink Polling interval time=64×(256×R_SLINK_POL_TIM_UP<1:0>+R_SLINK_POL_TIM_DN<7:0>+1)×tOSC *No Polling when R_SLINK_POL_TIM_UP=0 and R_SLINK_POL_TIM_DN=0	8'd124	M
0x0016	-	[4]	R_SLINK_SSR_EN	1	RW	Sublink SSR Enable 0:Disable 1:Enable	1'b1	M
0x0016	-	[1:0]	R_SLINK_SSR_TIM_UP	2	RW	Sublink SSR interval setting	2'd0	M
0x0017	-	[7:0]	R_SLINK_SSR_TIM_DN	8	RW	Sublink SSR interval time=64×(256×R_SLINK_SSR_TIM_UP<1:0>+R_SLINK_SSR_TIM_DN<7:0>+1)×tOSC *No SSR when R_SLINK_SSR_TIM_UP=0 and R_SLINK_SSR_TIM_DN=0	8'd249	M

To use GPIO (General Purpose Input/Output) pin, fault/error detection and interrupt function, “2-wire Set&Trigger mode1” enables remote register access. Sub-Link Master device has 2-wire serial slave block and can connect to HOST MPU, Sub-Link Slave device has 2-wire serial master block and can connect to remote side 2-wire serial slave devices.

HOST MPU can access register of Sub-Link Master device, Sub-Link Slave device and remote side 2-wire serial slave devices.

For “from remote THCV236 Sub-Link Master or from remote THCV242 Sub-Link mode1 or remote THCV244 Sub-Link mode1 to THCV243 Sub-Link Slave” access, “0x00FE” /”R_WB_MSB” and “R_WA_MODE” Word Address and Bank setting is required at the beginning before any read access. “0x00FE” Word Address write access from THCV236, THCV242 or THCV244 is supposed to be divided into “0x00” and “0xFE” commands by 8bit Sub-Address restriction.

Table 27. Sub-Link Word Address control setting

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master Addr(h)	Slave Addr(h)							
-	0x00FE	[6:4]	R_WB_MSB	3	RW	Word Address Bank MSB setting on 1Byte Word-addr. access from remote Sub-Link Master (e.g. THCV242) (active only when R_WA_MODE=1) 3'd1=3'b001:"Word Address MSB[15:8]" bank is "8'h00" 3'd2=3'b010:"Word Address MSB[15:8]" bank is "8'h10" 3'd3=3'b011:"Word Address MSB[15:8]" bank is "8'h11" others:Reserved	3'b0	S
-	0x00FE	[0]	R_WA_MODE	1	RW	Word Address Byte number setting from remote Sub-Link Master 0:2Byte Word Address access from remote Sub-Link Master 1:1Byte Word Address access from remote Sub-Link Master	1'b0	S

Under “1Byte Word Address access” operation (0x00FE bit0=1'b1), 1Byte access to 0xFE has the same meaning as 2Byte access to 0x00FE, being independent of “Word Address Bank MSB setting” (0x00FE bit[6:4]). This procedure enables users to reset Word Address Bank MSB setting on 1Byte Word Address access and Word Address Byte number setting itself.

6.20.1 Sub-Link 2-wire Set and Trigger mode (2-wire Normal mode)

Sub-Link Master 2-wire Set&Trigger mode1 (R_SLINK_MODE setting) is compatible with THCV236.

HOST MPU can access to Sub-Link Slave's register via THCV243 as Sub-Link Master only by THCV243 internal local register control and monitoring on 2-wire Set&Trigger mode1.

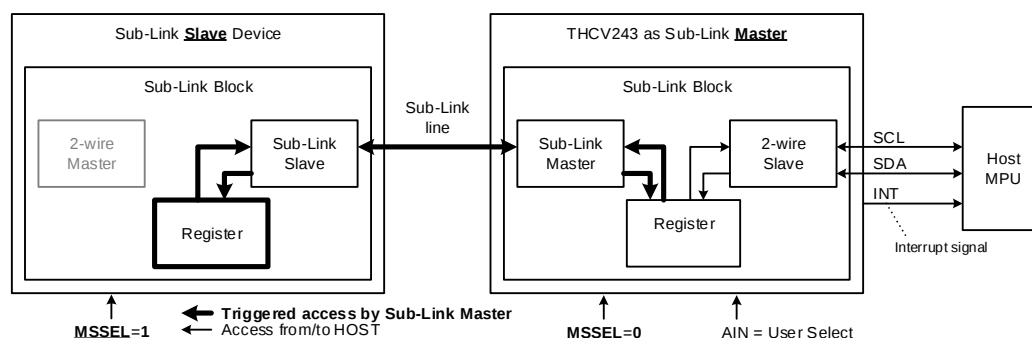


Figure 16. Host MPU to Sub-Link Slave Register via THCV243 access configuration

HOST MPU can access to remote side 2-wire serial slave register via THCV243 as Sub-Link Master only by THCV243 internal local register control and monitoring on 2-wire Set&Trigger mode1.

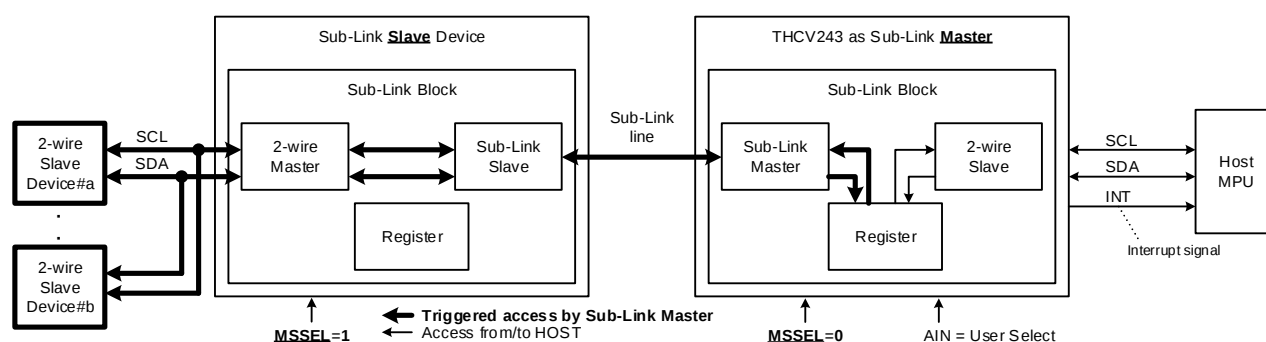


Figure 17. Host MPU to 2-wire slave devices connected to Sub-Link Slave via THCV243 access configuration

In principle, when Sub-Link bridges 2-wire serial interface communication from Sub-Link Master to Sub-Link Slave or remote side 2-wire serial slave devices, time lag occurs between HOST MPU side 2-wire serial access and Sub-Link Slave internal bus access or remote side 2-wire serial access.

R_2WIRE_CLKSEN (Sub-Link Master side register, 0x0042 bit0) selects whether 2-wire serial slave of Sub-Link Master perform clock stretching.

When R_2WIRE_CLKSEN = 1, Sub-Link Master device waits HOST MPU until Sub-Link Slave register access or remote side 2-wire serial slave register access complete by clock stretching.

When R_2WIRE_CLKSEN = 0, Sub-Link Master device informs HOST MPU that Sub-Link Slave register access or remote side 2-wire serial register access has completed by interruption (detectable on INT pin) without clock stretching.

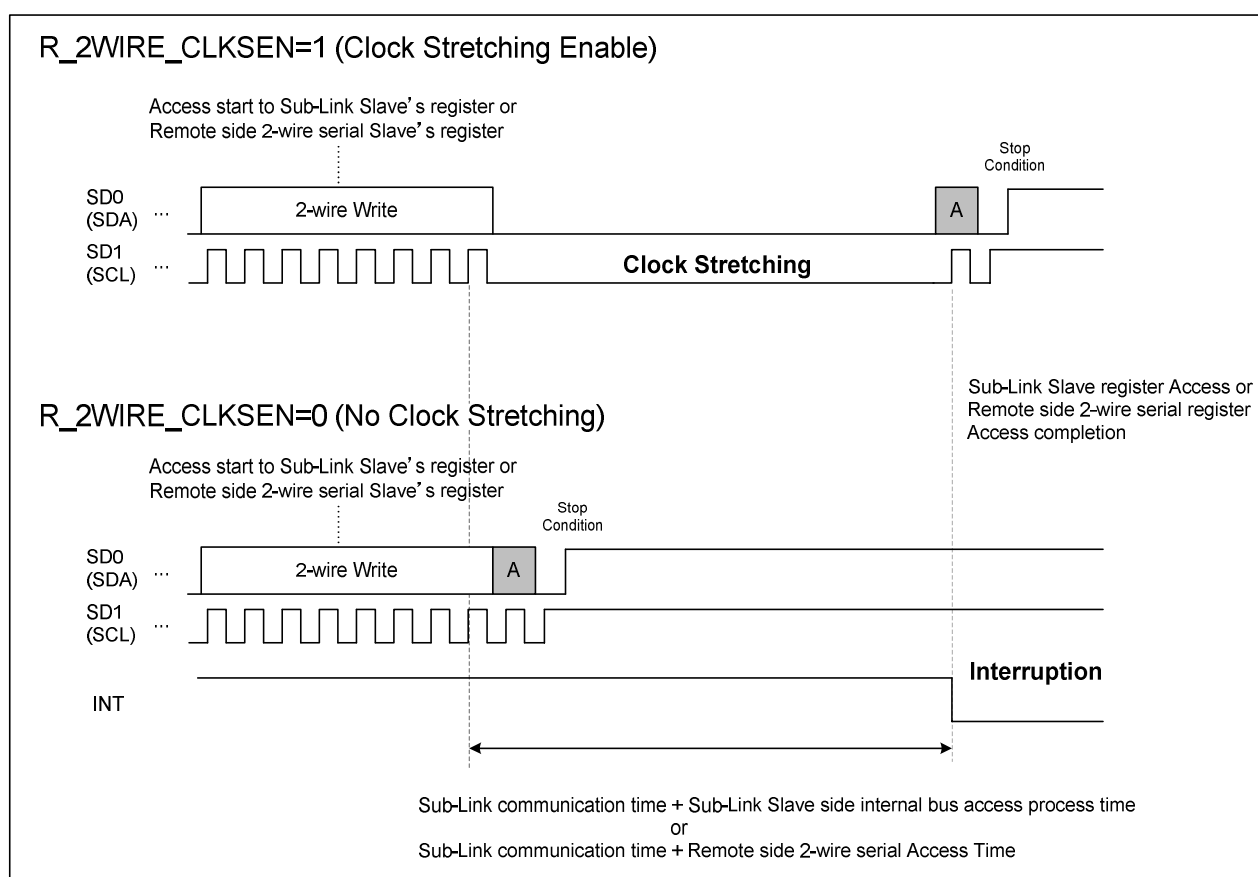


Figure 18. Sub-Link Master 2-wire slave clock stretching operation

Table 28. 2-wire serial I/F Set&Trigger mode remote access control and monitoring local registers

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
0x0030	-	[7:0]	R_2WIRE_DATA0	8	RW	2-wire serial I/F remote write/read data #0	8'd0	M
0x0031	-	[7:0]	R_2WIRE_DATA1	8	RW	2-wire serial I/F remote write/read data #1	8'd0	M
0x0032	-	[7:0]	R_2WIRE_DATA2	8	RW	2-wire serial I/F remote write/read data #2	8'd0	M
0x0033	-	[7:0]	R_2WIRE_DATA3	8	RW	2-wire serial I/F remote write/read data #3	8'd0	M
0x0034	-	[7:0]	R_2WIRE_DATA4	8	RW	2-wire serial I/F remote write/read data #4	8'd0	M
0x0035	-	[7:0]	R_2WIRE_DATA5	8	RW	2-wire serial I/F remote write/read data #5	8'd0	M
0x0036	-	[7:0]	R_2WIRE_DATA6	8	RW	2-wire serial I/F remote write/read data #6	8'd0	M
0x0037	-	[7:0]	R_2WIRE_DATA7	8	RW	2-wire serial I/F remote write/read data #7	8'd0	M
0x0038	-	[7:0]	R_2WIRE_DATA8	8	RW	2-wire serial I/F remote write/read data #8	8'd0	M
0x0039	-	[7:0]	R_2WIRE_DATA9	8	RW	2-wire serial I/F remote write/read data #9	8'd0	M
0x003A	-	[7:0]	R_2WIRE_DATA10	8	RW	2-wire serial I/F remote write/read data #10	8'd0	M
0x003B	-	[7:0]	R_2WIRE_DATA11	8	RW	2-wire serial I/F remote write/read data #11	8'd0	M
0x003C	-	[7:0]	R_2WIRE_DATA12	8	RW	2-wire serial I/F remote write/read data #12	8'd0	M
0x003D	-	[7:0]	R_2WIRE_DATA13	8	RW	2-wire serial I/F remote write/read data #13	8'd0	M
0x003E	-	[7:0]	R_2WIRE_DATA14	8	RW	2-wire serial I/F remote write/read data #14	8'd0	M
0x003F	-	[7:0]	R_2WIRE_DATA15	8	RW	2-wire serial I/F remote write/read data #15	8'd0	M
0x0040	-	[7:1]	R_2WIRE_DEVADR	7	RW	2-wire serial I/F remote access target device address. if target=self addr.; access to Sub-Link Slave inside register, else; access to remote side 2-wire serial Slave devices externally connected to Sub-Link slave	7'h00	M
0x0040	-	[0]	R_2WIRE_WR	1	RW	2-wire serial I/F remote access write or read select 0:Write 1:Read	1'b0	M
0x0041	-	[7]	reserved	1	-	-	-	-
0x0041	-	[6:4]	R_2WIRE_WADR_BYTE	3	RW	2-wire serial I/F remote device's Sub Address (Word Address, register address) Byte width select. address Byte width=R_2WIRE_WADR_BYTE<2:0>+1 0 : 1Byte= 8bit Sub addr.(register addr.) 1 : 2Byte=16bit Sub addr.(register addr.) 4 : 5Byte=40bit Sub addr.(register addr.), etc.	3'd0	M
0x0041	-	[3:0]	R_2WIRE_DATA_BYTE	4	RW	2-wire serial I/F remote access data Byte number Byte Number = R_2WIRE_DATA_BYTE + 1 (e.g. 0x2 for 3byte burst) [write rule] R_2WIRE_WADR_BYTE+R_2WIRE_DATA_BYTE =< 'd16 [read rule] R_2WIRE_DATA_BYTE<'d16	4'd0	M
0x0042	-	[7:1]	reserved	7	-	-	-	-
0x0042	-	[0]	R_2WIRE_CLKSEN	1	RW	2-wire serial I/F local response clock stretching Enable 0: Sub-Link Master (2-wire slave) No clock stretching 1: Sub-Link Master (2-wire slave) clock stretching Enable *2-wire Pass Through mode forces clock stretching Enable	1'b0	M
0x0043	-	[7:1]	reserved	7	-	-	-	-
0x0043	-	[0]	R_2WIRE_START	1	W	2-wire serial I/F remote access start trigger	-	M
-	-	[7:0]	reserved	8	-	-	-	-
-	-	[7:0]	reserved	8	-	-	-	-
-	-	[7:0]	reserved	8	-	-	-	-
-	-	[7:0]	reserved	8	-	-	-	-
-	0x00C8	[7:1]	reserved	7	-	-	-	-
-	0x00C8	[0]	R_2WIRE_BUS_CLR	1	W	2-wire serial I/F remote side bus clear Write 1: 2-wire bus clear action triggered from Sub-Link Slave (2-wire master) to 2-wire slave device connected to Sub-Link Slave. This bit is automatically cleared into 0 after reset action. 0 is always read.	-	S
-	0x00C9	[7:0]	R_2WIRE_SCL_HW	8	RW	SCL High width [tHIGH] setting on Sub-Link Slave side. Output SCL High width is defined as below. 16*(R_2WIRE_SCL_HW<7:0>+1) * tOSC	8'd31	S
-	0x00CA	[7:0]	R_2WIRE_SCL_LW	8	RW	SCL Low width [tLOW] setting on Sub-Link Slave side. Output SCL Low width is defined as below. 16*(R_2WIRE_SCL_LW<7:0>+1) * tOSC	8'd31	S

6.21 Sub-Link Watch Dog Timer

Sub-Link Watch Dog Timer (WDT) is installed to monitor status. When Sub-Link single transaction started but was not normally ended in time, WDT report Interrupt event of “R_INT_SLINK_TMOUT”.

Table 29. Sub-Link WDT setting

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
Addr(h)	Addr(h)							
0x0018	0x0098	[7:5]	reserved	3	-	-	-	-
0x0018	0x0098	[4]	R_SLINK_WD_EN	1	RW	Sublink WDT Enable 0:Disable 1:Enable	1'b1	MS
0x0018	0x0098	[3:2]	reserved	2	-	-	-	-
0x0018	0x0098	[1:0]	R_SLINK_WD_TIM_UP	2	RW	Sublink WDT time parameter	2'd0	MS
0x0019	0x0099	[7:0]	R_SLINK_WD_TIM_DN	8	RW	Sublink WDT time =64×(256×R_SLINK_WD_TIM_UP<1:0> + R_SLINK_WD_TIM_DN<7:0>+1) ×tOSC	8'd187	MS

6.22 Sub-Link Interrupt detection

For fault/error and significant event detection, Sub-Link prepares mechanism of monitoring for several internal status and interrupt notification. More than one selected factors are logically OR operated for INT pin output. At the same time the OR operated result is informed from Sub-Link Slave to Sub-Link Master.

Detectable interrupts both on Sub-Link Master and Slave are as follows.

- IC Internal event except Sub-Link
- Internal register Checksum error
- 2-wire access time out error
- Sub-Link CRC error
- Sub-Link protocol error
- Sub-Link access time out error

Detectable interrupts as Sub-Link Master are as follows.

- Main-Link LOCKN transition
- Main-Link HTPDN transition
- Sub-Link Slave side factor
- remote 2-wire access on Sub-Link end

Detectable interrupts as Sub-Link Slave are as follows.

- Sub-Link Slave 2-wire master bus clear end
- Sub-Link Slave 2-wire NACK detection

6.23 GPIO setting

Setting of GPIO can be configurable by 2-wire access to internal register.

6.23.1 Sub-Link Polling GPIO input/output

Local GPIO input is continuously reflected to remote GPIO output via Sub-Link polling. Input pins become target of interrupt monitoring.

Table 30. Sub-Link Polling GPIO setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x103D	[3:0]	R_GPIO_TYP	4	R/W	GPIO Mode Select [3]: 0:GPIO3 Register Mode, 1:GPIO3 Sub-Link Polling [2]: 0:GPIO2 Register Mode, 1:GPIO2 Sub-Link Polling [1]: 0:GPIO1 Register Mode, 1:GPIO1 Sub-Link Polling* [0]: 0:GPIO0 Register Mode, 1:GPIO0 Sub-Link Polling* *Sub-Link Polling is compatible with THCV236 GPIO Through mode	4'h0
0x103E	[3:0]	R_GPIO_OEN	4	R/W	GPIO0-3 Input/Output Select [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:GPIO Output Mode 1:GPIO Input Mode	4'hf
0x103F	[3:0]	R_GPIO_CMOSEN	4	R/W	GPIO0-3 CMOS/OpenDrain Select (When R_GPIO_OEN is set to GPIO Input Mode, the buffer must be CMOS.) [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:OpenDrain 1:CMOS	4'h0

As default setting with THCV236 as Sub-Link Master communication (THCV243 as Sub-Link Slave), GPIO1 Sub-Link Polling bridges output from THCV236-GPIO4 Through Mode and GPIO0 Sub-Link Polling bridges output from THCV236-GPIO3 Through Mode respectively.

As default setting with THCV242 or THCV244 as Sub-Link Master communication (THCV243 as Sub-Link Slave), GPIO1/0 Sub-Link Polling bridges output from THCV242 or THCV244-GPIO Through Mode and GPIO3/2 Sub-Link Polling bridges input to THCV242 or THCV244-GPIO Through Mode respectively.

Polling GPIO Bridging data are sampled every Sub-Link polling, whose basic interval is controlled by register R_SLINK_POL_TIM_UP/_DN. Remote 2-wire access may become long transaction and could lengthen Through GPIO polling reflection interval.

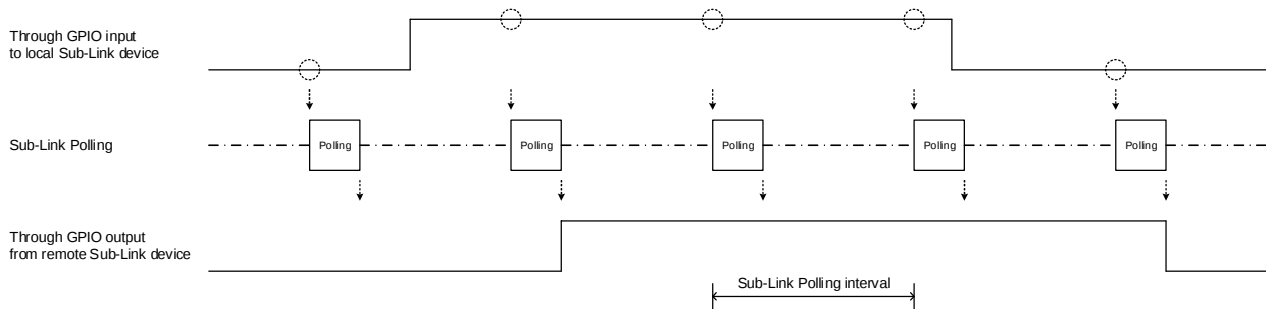


Figure 19. Host MPU to Sub-Link Slave Register via THCV243 access configuration

Remote UART bridge is supported with Sub-Link Polling GPIO input/output. Remote UART Tx and Rx bridge baud rate is supposed to be designed against Sub-Link Polling interval to accommodate deterministic jitter caused by intermittent Sub-Link communication timing.

6.23.2 Register GPIO

GPIO input monitoring and output control are available with register. Input pins become target of interrupt monitoring.

Table 31. Register GPIO setting and status monitoring

Addr(h)	Bits	Register	width	R/W	Description	Default
0x103D	[3:0]	R_GPIO_TYP	4	R/W	GPIO Mode Select [3]: 0:GPIO3 Register Mode, 1:GPIO3 Sub-Link Polling [2]: 0:GPIO2 Register Mode, 1:GPIO2 Sub-Link Polling [1]: 0:GPIO1 Register Mode, 1:GPIO1 Sub-Link Polling* [0]: 0:GPIO0 Register Mode, 1:GPIO0 Sub-Link Polling* *Sub-Link Polling is compatible with THCV236 GPIO Through mode	4'h0
0x103E	[7:4]	R_GPIO_OUT	4	R/W	GPIO0-3 Output Data Register [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0	4'h0
0x103E	[3:0]	R_GPIO_OEN	4	R/W	GPIO0-3 Input/Output Select [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:GPIO Output Mode 1:GPIO Input Mode	4'hf
0x103F	[3:0]	R_GPIO_CMOSEN	4	R/W	GPIO0-3 CMOS/OpenDrain Select(When R_GPIO_OEN is set to GPIO Input Mode, the buffer must be CMOS.) [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:OpenDrain 1:CMOS	4'h0
0x1121	[7:4]	R_GPIO_IMON	4	R	GPIO0-3 Input Monitor Register [7]:GPIO3, [6]:GPIO2, [5]:GPIO1, [4]:GPIO0	-
0x1121	[3:0]	R_GPIO_INT_DETECT	4	R	Interrupt Signal for GPI [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:No Interrupt 1:Interrupt (detect for asserted or negated of GPI Input)	-
0x1122	[3:0]	R_GPIO_INTC_DETECT	4	W	Interrupt Clear for GPI [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0:Interrupt No Clear 1:Interrupt Clear	-

6.24 Internal Error / status signal monitoring GPIO output

Internal error or status signal can be monitored as GPIO output by register setting.

Table 32. Internal Error / status signal monitoring GPIO output setting 1/2

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1038	[6:4]	R_GPIO_SEL0	3	R/W	GPIO0-3 Error / status output select 3b'000:Normal	3'h0
0x1038	[2:0]	R_GPIO_SEL1			3b'001:R_ERR_SEL1(Internal Selected Error1)	
0x1039	[6:4]	R_GPIO_SEL2			3b'010:R_ERR_SEL2(Internal Selected Error2)	
0x1039	[2:0]	R_GPIO_SEL3			3b'011:R_EXT_ERR_SEL0(External Selected Error1) 3b'100:R_EXT_ERR_SEL1(External Selected Error2) Others:Normal	
0x105D	[7:4]	R_ERR_SEL1	4	R/W	Internal Selected Error1 output to GPIO and Sub-Link	4'h0
0x105D	[3:0]	R_ERR_SEL2	4	R/W	Internal Selected Error2 output to GPIO and Sub-Link	4'h0

Table 33. Internal Error / status signal monitoring GPIO output setting 2/2

Sub-Link		Bits	Register	width	R/W	Description	Default	Master or Slave related
Master	Slave							
0x006E	0x00EE	[7:4]	R_SLINK_ERR_SEL1	4	RW	Sublink Polling to inform error signal select #1	4'd0	MS
0x006D	0x00ED	[3:0]	R_SLINK_ERR_SEL0	4	RW	Sublink Polling to inform error signal select #0	4'd0	MS
0x006F	0x00EF	[7:4]	R_EXT_ERR_SEL1	4	RW	Sub-Link operator Selected Error#1 output to GPIO	4'd0	MS
0x006F	0x00EF	[3:0]	R_EXT_ERR_SEL0	4	RW	Sub-Link operator Selected Error#0 output to GPIO	4'd0	MS

Table 34. IC Internal Selectable Error / status signal

R_ERR_SEL1/2[3:0]	Error signal
4'b0000	reserved
4'b0001	MIPI CRC error
4'b0010	MIPI ECC 1bit error
4'b0011	MIPI ECC 2bit error
4'b0100	MIPI ID error (MIPI ID is not equal to Main-Link setting)
4'b0101	MIPI SoT sequence not detected error
4'b0110	MIPI SYNCCODE SoT 1bit error
4'b0111	MIPI FRAMESYNC FS/FE position error
4'b1000	reserved
4'b1001	MIPI Control state error
4'b1010	MIPI FS
4'b1011	MIPI FE
4'b1100	reserved
4'b1101	reserved
4'b1110	Main-Link Data Handle error
4'b1111	PLL auto configuration setting error

Table 35. IC External sub-link operator selectable Error / status signal

R_SLINK_ERR_SEL[n[3:0]] (n=0,1) R_EXT_ERR_SEL[n[3:0]] (n=0,1)	Assignment on Sub-Link Master (MSSEL=0)	Assignment on Sub-Link Slave (MSSEL=1)
'h00	R_ERR_SEL1	
'h01	R_ERR_SEL2	
'h02	R_SLINK_ERR_SEL0 of Sub-Link Slave	R_SLINK_ERR_SEL0 of Sub-Link Master
'h03	R_SLINK_ERR_SEL1 of Sub-Link Slave	R_SLINK_ERR_SEL1 of Sub-Link Master
'h04	R_INT_EXTERNAL	
'h05	R_INT_CKSUM_ERR	
'h06	R_INT_I2C_TMOUT	
'h07	1'b0	
'h08	R_INT_SLINK_PROTERR	
'h09	R_INT_SLINK_TMOUT	
'h0A	R_INT_LOCKN	1'b0
'h0B	R_INT_HTPDN	1'b0
'h0C	R_INT_SLAVESIDE	1'b0
'h0D	R_INT_EXTI2C_ACSEND	1'b0
'h0E	1'b0	R_INT_EXTI2CS_BUSCLR
'h0F	1'b0	R_INT_EXTI2CS_NACK

6.25 Internal Error / status signal monitoring register

Internal error or status signal can be monitored as register read value.

Error count register can be cleared by particular register write “1” access.

Error status register can be masked to “0” fixed by particular register appropriate write access.

Table 36. Internal Error / status signal monitoring register

Module	ERR / ERR_CNT	CLEAR	MASK/EN/OFF	Description
Main-Link	R_DHNDL_ERR	-	R_DHNDL_INT_MSK	Main-Link Data Handle error
PLL	PLL_SET_NG	-	R_PLL_SET_NG_MSK	PLL auto configuration setting error
MIPI	R_RX_CRC_ERR_CNT[15:0]	R_CRC_ERR_CNT_CLR	-	CRC error count by every Line
MIPI	R_RX_ECC_ERR_CRCT_CNT[15:0]	R_ECC_ERR_CRCT_CNT_CLR	-	ECC1bit error count by every Line
MIPI	R_RX_ECC_ERR_DBLE_CNT[15:0]	R_ECC_ERR_DBLE_CNT_CLR	-	ECC2bit error count by every Line
Sub-Link	R_SLINK_FBETERR_NUM_*(15:0)	R_SLINK_FBETERR_CLR	-	Sub-link Feald BET error count

*H:Enable L:Disable, which is defferent polarity from other mask registers

6.26 Interrupt monitoring

Interrupt (INT) detects occurrence of internal error or status signal and then, latch the detected state.

Interrupt factor can be cleared by particular register write “1” access.

Interrupt factor can be masked to “0” fixed by particular register appropriate write access.

Table 37. Interrupt monitoring

Module	INT	CLEAR	MASK/EN/OFF	Description
MIPI	R_ERR_CRC	R_CRC_ERR_CLR	R_CRC_CMP_MSK	MIPI CRC error
MIPI	R_ERR_ECCCOR	R_ECC_CRCT_ERR_CLR	R_ECC1_CMP_MSK	MIPI ECC 1bit error
MIPI	R_ERR_ECCDBL	R_ECC_DOUBLE_ERR_CLR	R_ECC2_CMP_MSK	MIPI ECC 2bit error
MIPI	R_ERR_ID	R_ERR_ID_CLR	R_ERR_ID_MSK	MIPI ID error (MIPI ID is not equal to Main-Link setting)
MIPI	R_ERR_SOTSYNC[3:0]	R_SOT_SYNC_HS_CLR[3:0]	R_ERR_SOT_HS_MSK_R[3:0]	MIPI SoT sequence not detected error
MIPI	R_ERR_SYNCODE[3:0]	R_SOT_SYNCODE_CLR[3:0]	R_RX_IGNORE_DERR[3:0]	MIPI SYNCODE SoT 1bit error
MIPI	R_ERR_FRAMESYNC[3:0]	R_ERR_FR_SYNC_ON_CLR[3:0]	R_ERR_FR_SYNC_MSK_R[3:0]	MIPI FRAMESYNC FS/FE position error
MIPI	R_ERR_CONTROL[4:0]	R_ERR_CTL_CLR[4:0]	R_ERR_CTL_MSK[4:0]	MIPI Control state error
MIPI	R_INT_FS[3:0]	R_INT_FS_ON_CLR[3:0]	R_INT_FS_MSK_R[3:0]	MIPI FS
MIPI	R_INT_FE[3:0]	R_INT_FE_ON_CLR[3:0]	R_INT_FE_MSK_R[3:0]	MIPI FE
Main-Link	R_DHNDL_INT	R_DHNDL_INT_CLR	R_DHNDL_INT_MSK	Main-Link Data Handle error
GPIO	R_GPIO_INT_DETECT[3:0]	R_GPIO_INTC_DETECT[3:0]	R_GPIO_INTM_DETECT[3:0]	GPIO input transition detect
Sub-Link	R_INT_EXTERNAL	R_INTC_EXTERNAL	R_INTM_EXTERNAL	IC Internal event except Sub-Link
Sub-Link	R_INT_CKSUM_ERR	R_INTC_CKSUM_ERR	R_INTM_CKSUM_ERR	Internal register Checksum error
Sub-Link	R_INT_I2C_TMOUT	R_INTC_I2C_TMOUT	R_INTM_I2C_TMOUT	2-wire access time out error
Sub-Link	R_INT_SLINK_PROTERR	R_INTC_SLINK_PROTERR	R_INTM_SLINK_PROTERR	Sub-Link protocol error
Sub-Link	R_INT_SLINK_TMOUT	R_INTC_SLINK_TMOUT	R_INTM_SLINK_TMOUT	Sub-Link access time out error
Sub-Link	R_INT_LOCKN	R_INTC_LOCKN	R_INTM_LOCKN	Main-Link LOCKN transition
Sub-Link	R_INT_HTPDN	R_INTC_HTPDN	R_INTM_HTPDN	Main-Link HTPDN transition
Sub-Link	R_INT_SLAVESIDE	R_INTC_SLAVESIDE	R_INTM_SLAVESIDE	Sub-Link Slave side factor
Sub-Link	R_INT_EXTI2C_ACSEND	R_INTC_EXTI2C_ACSEND	R_INTM_EXTI2C_ACSEND	remote 2-wire access on Sub-Link end
Sub-Link	R_INT_EXTI2CS_BUSCLR	R_INTC_EXTI2CS_BUSCLR	R_INTM_EXTI2CS_BUSCLR	Sub-Link Slave 2-wire master bus clear end
Sub-Link	R_INT_EXTI2CS_NACK	R_INTC_EXTI2CS_NACK	R_INTM_EXTI2CS_NACK	Sub-Link Slave 2-wire NACK detection

As a register, interrupt detected state is “1” and cleared state is “0”. When multiple interrupt sources are activated, the OR operated result is indicated as IC external INT pin output, which at the same time can be sent to Sub-Link counterpart device.

As an external INT pin output, open drain output interrupt detected state is “Low” and cleared state is “Hi-Z”, while INT pin CMOS push-pull output interrupt detected state is “High” and cleared state is “Low”.

Table 38. INT pin output control

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1041	[0]	R_INT_CMOSEN	1	R/W	[IO] INT CMOS/OpenDrain Select 0:OpenDrain 1:CMOS	1'h0

INT interrupt function is supposed to be cleared before start monitoring any desired status because INT status may have been changed before monitoring activation.

For Sub-Link remote interrupt bridge, Sub-Link Master prepares “SLAVESIDE” interrupt factor monitoring element. This Sub-Link SLAVESIDE interrupt monitoring element connected to THCV243 Sub-Link block of THCV243 as Sub-Link Slave.

MIPI, Main-Link, GPIO and other modules of THCV243 are designed as separated module and not included in Sub-Link Module so that R_INT_EXTERNAL factor must be set as “No mask” in order to report those MIPI, Main-Link, GPIO and other Interrupt factor to remote Sub-Link Master.

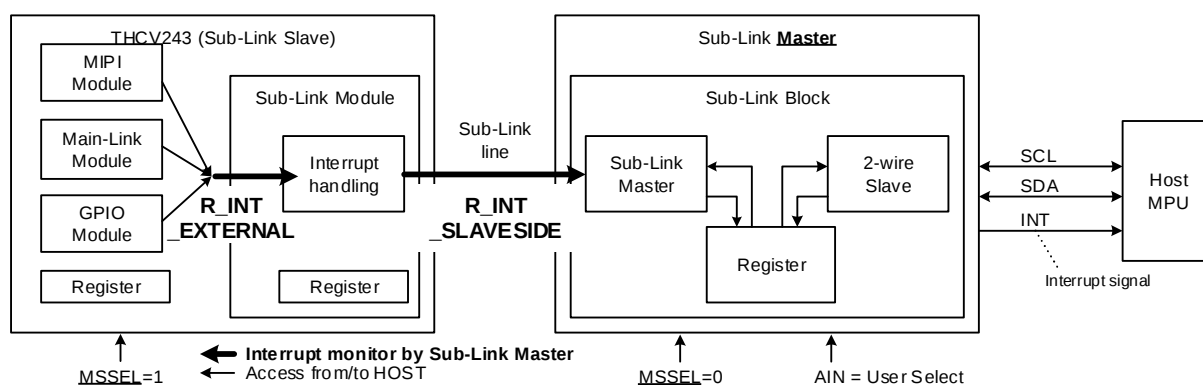


Figure 20. Interrupt configuration external of Sub-Link module.

6.27 Build-In Self Test pattern generator (BIST)

RGB888 3Byte mode pattern generator is available. Hsync width is 1 pixel fixed. Vsync width is 1 line fixed. Generated pattern is transmitted on Main-Link. As of V-by-One® HS output format, R_OUTPUT_FMT register value is ignored and format is fixed to RGB888 when R_BISTEN = 1, Enabled.

Table 39. V-by-One® HS Build-In Self Test pattern generator (BIST) setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1004	[1]	R_VSYNC_POL	1	R/W	V-by-One® HS Vsync polarity 0:High pulse (High active) (THCV242-Q default) 1:Low pulse (Low active)	1'h0
0x1004	[0]	R_HSYNC_POL	1	R/W	V-by-One® HS Hsync polarity 0:High pulse (High active) (THCV242-Q default) 1:Low pulse (Low active)	1'h0
0x105F	[0]	R_BISTEN	1	R/W	BIST Enable 0:Disable 1:Enable	1'h0
0x1060	[4:0]	R_BIST_PTN	5	R/W	BIST pattern select 00: Automatic pattern switching repetition from 01 to 0E 01~05: raster patterns 06~07: color bar patterns 08~0B: ramp patterns 0C: 16x16 pixel checker 0D: Frame 0E: Sub checker 0F: reserved 10: Frame2 11~16: checkers 17: Cursor 18~1F: reserved	5'h00
0x1061	[7:0]	R_GS_SEL_R	8	R/W	BIST Gradient Setting Red 00:Black <=> FF:Red	8'hff
0x1062	[7:0]	R_GS_SEL_G	8	R/W	BIST Gradient Setting Green 00:Black <=> FF:Green	8'hff
0x1063	[7:0]	R_GS_SEL_B	8	R/W	BIST Gradient Setting Blue 00:Black <=> FF:Blue	8'hff
0x1064	[3:0]	R_CURSORH[11:8]	4	R/W	BIST Cursor position on horizontal direction	4'h0
0x1065	[7:0]	R_CURSORH[7:0]	8	R/W	BIST Cursor position on horizontal direction	8'h00
0x1066	[3:0]	R_CUSOV[11:8]	4	R/W	BIST Cursor position on vertical direction	4'h0
0x1067	[7:0]	R_CUSOV[7:0]	8	R/W	BIST Cursor position on vertical direction	8'h00
0x1068	[1:0]	R_HACTIVE_V[9:8]	2	R/W	BIST Hactive pixel number setting Hactive pixel number = "R_HACTIVE_V" x4	2'h1
0x1069	[7:0]	R_HACTIVE_V[7:0]	8	R/W	BIST Hactive pixel number Hactive pixel number = "R_HACTIVE_V" x4	8'hE0
0x106A	[2:0]	R_VACTIVE_V[10:8]	3	R/W	BIST Vactive line number (must be even number)	3'h4
0x106B	[7:0]	R_VACTIVE_V[7:0]	8	R/W	BIST Vactive line number (must be even number)	8'h38
0x106C	[1:0]	R_HBLANK_V[9:8]	2	R/W	BIST Hblank pixel number setting Hblank pixel number = "R_HBLANK_V" x4	2'h0
0x106D	[7:0]	R_HBLANK_V[7:0]	8	R/W	BIST Hblank pixel number Hblank pixel number = "R_HBLANK_V" x4	8'h46
0x106E	[1:0]	R_VBLANK_V[9:8]	2	R/W	BIST Vblank line number	2'h0
0x106F	[7:0]	R_VBLANK_V[7:0]	8	R/W	BIST Vblank line number	8'h27
0x1070	[0]	R_HBP_V[8]	1	R/W	BIST Hbackporch pixel number setting Hbackporch pixel number = "R_HBP_V" x4	1'h0
0x1071	[7:0]	R_HBP_V[7:0]	8	R/W	BIST Hbackporch pixel number setting Hbackporch pixel number = "R_HBP_V" x4	8'h28
0x1072	[6:0]	R_VBP_V	7	R/W	BIST Vbackporch line number	7'h10

Automatic pattern switching BIST repetition is available.

Gradient setting only effects on particular patterns.

Cursor position can be set by “R_CURSOR_H”, “R_CURSOR_V” resistor.

Table 40. V-by-One® HS Build-In Self Test (BIST) selectable patterns

BIST_PTN[4:0]	Pattern	Gradient setting effect	Automatic switch order	BIST_PTN[4:0]	Pattern	Gradient setting effect	Automatic switch order
00	Automatic switch BIST	Available	-	10	Frame2	N/A	-
01	White raster	Available	1	11	4N/A1 checker 1	Available	-
02	Black raster	N/A	2	12	4N/A1 checker 2	N/A	-
03	Red raster	Available	3	13	2N/A1 checker 1	Available	-
04	Green raster	Available	4	14	2N/A1 checker 2	N/A	-
05	Blue raster	Available	5	15	1N/A1 checker 1	Available	-
06	Horizontal color bars	Available	6	16	1N/A1 checker 2	N/A	-
07	Vertical color bars	Available	7	17	Cursor	Available	-
08	Horizontal gray ramp	N/A	8	18	reserved	N/A	-
09	Vertical gray ramp	N/A	9	19	reserved	N/A	-
0A	Horizontal RGBW ramp	N/A	10	1A	reserved	N/A	-
0B	Vertical RGBW ramp	N/A	11	1B	reserved	N/A	-
0C	16N/A16 pin/Ael checker	Available	12	1C	reserved	N/A	-
0D	Frame	Available	13	1D	reserved	N/A	-
0E	Sub pixel checker	Available	14	1E	reserved	N/A	-
0F	reserved	N/A	-	1F	reserved	N/A	-

6.28 Main-Link Field BET

In order to help users to check validity of CML serial line (Main-Link and Sub-Link), THCV243 and particular V-by-One® HS receiver have an operation mode in which they act as a bit error tester (BET). In Main-Link Field BET mode, THCV243 internally generates test pattern which is then serialized onto the Main-Link CML line. The counterpart particular receiver, that also has BET function mode, receives the data stream and checks bit errors. The generated data pattern is then 8b/10b encoded, scrambled, and serialized onto the CML channel. As for the receiver, the internal test pattern check circuit gets enabled and reports result on a certain pin or register.

Table 41. V-by-One® HS Field BET pattern generator setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1052	[1]	R_ML_BETEN	1	R/W	V-by-One® HS Main Filed-BET Enable 0 : Normal Mode 1 : Filed-BET Mode	1'h0

6.29 Sub-Link Field BET operation and output from GPIO

In Sub-Link Field BET mode, Sub-Link Master device internally generates test pattern which is then serialized onto the Sub-Link line. Sub-Link Slave device also has BET function mode. Sub-Link Slave device receives the data stream and checks bit errors. Note that Sub-Link Slave device must be set this mode prior to Sub-Link Master device. Pattern check result is output from BETOUT pin of the Sub-Link Slave device. The BETOUT pin goes LOW whenever bit errors occur, or it stays HIGH when there is no bit error.

LATEN enables latched result of once-error-detected. BETOUT/LATEN output pin is assigned according to priority GPIO0 > GPIO1 > GPIO2 > GPIO3 when the same Sub-Link Field BET MODE Signal overlap several pins as register setting.

Table 42. Sub-Link Field BET result GPIO output setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1056	[0]	R_SUB_BETEN	1	R/W	Sub-Link Filed-BET Enable 0 : Normal Mode 1 : Filed-BET Mode	1'h0
0x1057	[7:0]	R_SUB_BETSEL	8	R/W	Sub-Link Field-BET MODE Signal Select [7:6] 10 : GPIO3 BETOUT 01 : GPIO3 LATEN 11,00 : Don't Care [5:4] 10 : GPIO2 BETOUT 01 : GPIO2 LATEN 11,00 : Don't Care [3:2] 10 : GPIO1 BETOUT 01 : GPIO1 LATEN 11,00 : Don't Care [1:0] 10 : GPIO0 BETOUT 01 : GPIO0 LATEN 11,00 : Don't Care	8'h06

6.30 CMOS IO Input Noise Filter

IO Filter is available and applied default.

Table 43. CMOS IO input noise filter

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1048	[3:0]	R_IOFLT_RANGE1	4	R/W	CMOS IO Input Signal Noise Filter Setting for PDN1, MSSEL, AIN 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*16 (ns)	4'h4
0x1049	[3:0]	R_IOFLT_RANGE2	4	R/W	CMOS IO Input Signal Noise Filter Setting for SCL, SDA 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h2
0x104A	[3:0]	R_IOFLT_RANGE3	4	R/W	CMOS IO Input Signal Noise Filter Setting for GPIO0 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h4
0x104B	[3:0]	R_IOFLT_RANGE4	4	R/W	CMOS IO Input Signal Noise Filter Setting for GPIO1 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h4
0x104C	[3:0]	R_IOFLT_RANGE5	4	R/W	CMOS IO Input Signal Noise Filter Setting for GPIO2 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h4
0x104D	[3:0]	R_IOFLT_RANGE6	4	R/W	CMOS IO Input Signal Noise Filter Setting for GPIO3 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h4
0x104E	[3:0]	R_IOFLT_RANGE7	4	R/W	CMOS IO Input Signal Noise Filter Setting for LOCKN 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*2 (ns)	4'h4
0x104F	[3:0]	R_IOFLT_RANGE8	4	R/W	CMOS IO Input Signal Noise Filter Setting for PDN0 0:No Filter n:Filtering Glitch Signal when Pulse Width is Less than tOSC*n*16 (ns)	4'hF

6.31 CMOS output drive strength

CMOS output drive strength can be configurable.

Table 44. CMOS output drive strength setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1040	[3:0]	R_GPIO_TDRV	4	R/W	GPIO0-3 CMOS IO Drive Strength Select [3]:GPIO3, [2]:GPIO2, [1]:GPIO1, [0]:GPIO0 0: Normal Drive(4mA) 1: Strong Drive(8mA)	4'h0
0x1047	[6:0]	R_IO_DRV[7:0]	8	R/W	CMOS IO Drive Strength Select [6]:INT, [3]:CKO, [1]:SDA, [0]:SCL [5], [4], [2]:ReservedL 0: Normal Drive(4mA) 1: Strong Drive(8mA)	7'h00

6.32 CKO reference clock buffer output

CKO reference clock buffer output can be configurable by 2-wire access to internal register.

Table 45. CKO setting

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1076	[6]	R_CKOSTOP	1	R/W	CKO output source select 0:CKI, 1: Low fix	1'h1

6.33 Soft Reset

Soft Reset is available by 2-wire access to internal register.

PLL and V-by-One® HS initial statuses are reset state; therefore Soft Reset is supposed to be released in accordance with appropriate sequence: PLL Soft Reset release => V-by-One® HS TX Soft Reset release.

Table 46. Soft Reset register

Addr(h)	Bits	Register	width	R/W	Description	Default
0x1005	[0]	R_PLL_SNRST	1	R/W	Software Reset for PLL 0:Software Reset Active 1:Software Reset Release (PLL Normal Operation)	1'h0
0x1006	[0]	R_TX_SNRST	1	R/W	Software Reset for V-by-One® HS TX 0:Software Reset Active 1:Software Reset Release (Vx1HS TX Normal Operation)	1'h0
0x1022	[0]	R_DCLKSNRST	1	R/W	Digital logic Clock Soft Reset 0:Reset 1:Reset Release (Digital logic Clock Normal Operation)	1'h1
0x1023	[0]	R_MCLKSNRST	1	R/W	MIPI Clock Soft Reset 0:Reset 1:Reset Release (MIPI Clock Normal Operation)	1'h1
0x10FF	[7:0]	R_REGSNRST	8	R/W	Register Soft Reset AA:Reset others:Reserved	8'h00

Also, change of PLL and V-by-One® HS parameters automatically cause Soft Reset without any touch on R_PLL_SNRST nor R_TX_SNRST, whose temporary reset time length can be defined by R_PLL_CTERM and R_TX_CTERM respectively.

Table 47. Automatic Soft Reset of PLL and V-by-One® HS recovery time control

Addr(h)	Bits	Register	width	R/W	Description	Default
0x105B	[7:0]	R_PLL_CTERM	8	R/W	PLL parameter change automatic reset recovery time length 00 Disable(Disable Auto Soft Reset) 01 1*256*tOSC (typ.3.2us) 02 2*256*tOSC (typ.6.4us) 03 3*256*tOSC (typ.9.6us) : : FE 254*256*tOSC (typ.812.8us) FF 255*256*tOSC (typ.816us)	8'h55
0x105C	[7:0]	R_TX_CTERM	8	R/W	V-by-One® HS parameter change automatic reset recovery time length 00 Disable(Disable Auto Soft Reset) 01 1*256*tOSC (typ.3.2us) 02 2*256*tOSC (typ.6.4us) 03 3*256*tOSC (typ.9.6us) : : FE 254*256*tOSC (typ.812.8us) FF 255*256*tOSC (typ.816us)	8'h55

The registers that may trigger PLL automatic Soft Reset are as follows.

If R_PLL_SET_MODE=0,

R_CK1_FREQ

R_MIPI_MULT

R_OUTPUT_FMT

R_HFSEL

R_RX_LANE_SEL_EN

else if R_PLL_SET_MODE=1,

R_PLL_SETTING[47:0]

R_DIVVAL

on both R_PLL_SET_MODE=0 and R_PLL_SET_MODE=1,

R_SPREAD

R_DISABLE_SSCG

The registers that may trigger V-by-One® HS automatic Soft Reset are as follows.

R_NHSEL

R_LFQEN

R_ML0_PRE

R_ML0_DRV

R_COL_SEL

R_COL_MAN[1:0]

R_OUTPUT_FMT

R_HFSEL

R_BITMAP_SEL

6.34 Power On Sequence

Power On Sequence must be controlled appropriate.

MIPI, PLL and V-by-One® HS block are reset state at power on default and require Reset Release.

. MIPI Soft Reset / PLL Soft Reset => V-by-One® HS Soft Reset is proper. See below detail.

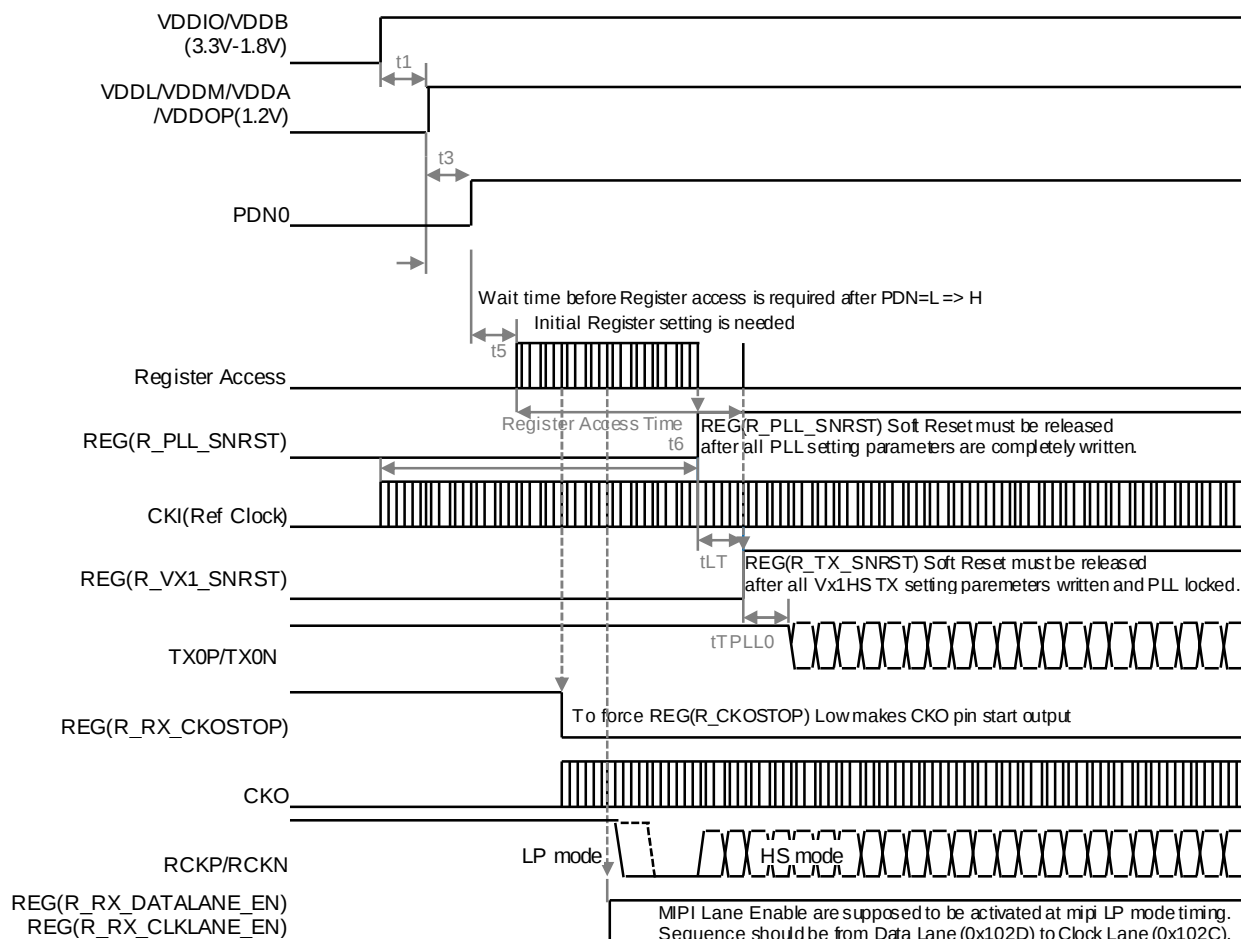


Figure 21. Power On Sequence procedure

Table 48. Power On Sequence specification

symbol	discription	min	typ	max	unit
t1	3.3V to 1.2V	0	-	-	us
t3	PDN0 Reset Rerease Time	0	-	-	us
t5	Required wait from PDN0=H to Register Access	300	-	-	us
t6	Required wait from CKI input to PLL Enable	200	-	-	us
tLT	Required wait from PLL Lock Time to CML output	$\frac{1000}{F(CKI)}$	-	-	us
tTPLL0	V-by-One® HS Reset Release to CML Out Delay	-	-	250	us

6.35 Lock / Re-Lock Sequence

Lock and re-lock sequence are as follows. V-by-One® HS automatically shifts into lock status from initial status or unlock status caused by external noise under appropriate parameter set condition.

LOCK Sequence

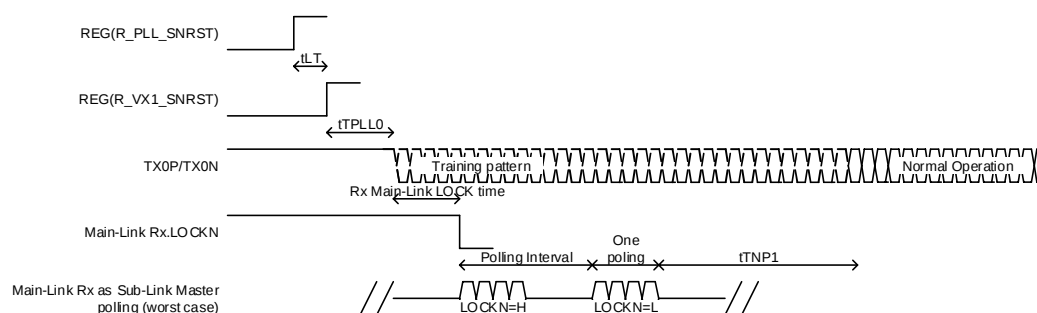


Figure 22. Lock Sequence

Re-LOCK Sequence

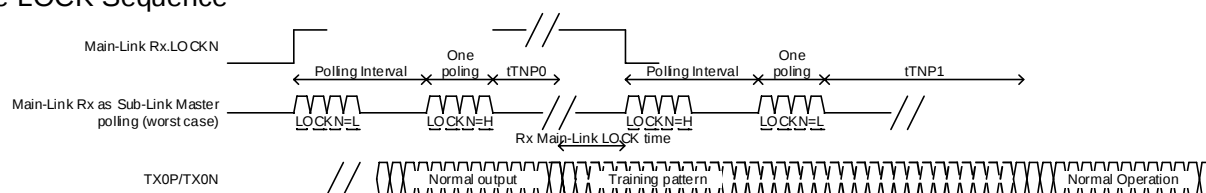


Figure 23. Re-Lock Sequence

Table 49. Lock / Re-Lock Sequence specification

symbol	discription	min	typ	max	unit
tTNP0	LOCKN=H to Training pattern output delay	-	-	2	us
tTNP1	LOCKN=L to Data pattern output delay	-	-	$\frac{1200}{F(OUT)}$	us

7 Absolute Maximum Ratings

Table 50. Absolute Maximum Ratings*

Parameter	Min	Typ	Max	Unit
Supply Voltage VDDH	-0.3	-	4	V
Supply Voltage VDD12 (VDDM, VDDLOP, VDDA)	-0.3	-	1.6	V
LVC MOS Input Voltage	-0.3	-	VDDH+0.3 *1	V
MIPI Input Voltage	-0.3	-	VDDM+0.3 *2	V
CML Transmitter Output Voltage	-0.3	-	VDDA+0.3 *2	V
CML Bi-directional buffer Input / Output Voltage	-0.3	-	VDDH+0.3 *1	V
Storage Temperature Range	-55	-	125	°C
Junction temperature	-	-	125	°C
Reflow Peak Temperature/Time	-	-	260/10	°C/sec

*1 Max. must be below 4V at the same time

*2 Max. must be below 1.6V at the same time

* “Absolute Maximum Ratings” are values of safety limit for a device beyond which a device safety cannot be guaranteed.

They do not imply that a device should be operated at these limits. The tables of “Recommended Operating Condition” specify conditions for device operation.

8 Recommended Operating Conditions

Table 51. Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Unit
VDDH	Supply Voltage	3.3V Drive	3.0	3.3	3.6	V
		2.5V Drive	2.0	2.5	3.0	V
		1.8V Drive	1.7	1.8	2.0	V
VDD12	Supply Voltage 1.2V (VDDM, VDDLOP, VDDA)	-	1.1	-	1.3	V
Ta	Operating Ambient Temperature	-	-40	-	105	°C

9 Consumption Current

Table 52. Consumption Current

Symbol	Parameter	Condition	Min	Typ	Max	Unit
ICCS33	Power Down Supply Current	PDN1=0, PDN0=0, VDDH=3.3V	-	0.04	-	mA
ICCS12		PDN1=0, PDN0=0, VDD12=1.2V	-	8	-	mA
ICCW12_33	VDDH=3.3V	PDN1=1	-	16	27	mA
ICCW12_18	VDDH=1.8V	PDN1=1	-	14	22	mA
ICCW12_18	1080p60fps RAW, MPRF	891Mbps x2Lane input / 2.2275Gbps output	-	81	154	mA
ICCW12_30	quasi-1080p high fps, MPRF	800Mbps x4Lane input / 4Gbps output	-	106	168	mA

10 DC Specifications

10.1 CMOS DC Specifications

Table 53. CMOS DC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
I _{IH}	LVC MOS Input Leak Current High	-	-	-	10	uA
I _{IL}	LVC MOS Input Leak Current Low	-	-	-	10	uA
V _{IHI} O	LVC MOS High Level Input Voltage	3.3V Drive	2.1	-	V _{DDH}	V
		2.5V Drive	0.75*V _{DDH}	-	V _{DDH}	V
		1.8V Drive	0.7*V _{DDH}	-	V _{DDH}	V
V _{IL} I O	LVC MOS Low Level Input Voltage	3.3V Drive	0	-	0.7	V
		2.5V Drive	0	-	0.25*V _{DDH}	V
		1.8V Drive	0	-	0.25*V _{DDH}	V
V _{OH}	LVC MOS High Level Output Voltage	I _{OH} =1mA	V _{DDH} -0.45	-	V _{DDH}	V
V _{OL}	LVC MOS Low Level Output Voltage	I _{OL} =1mA	0	-	0.45	V

10.2 CML Transmitter DC Specifications

Table 54. CML Transmitter DC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
V _{TOD}	CML Differential Mode Output Voltage	R _{ML0_DRV} [1:0]=00	133	200	267	mV
		R _{ML0_DRV} [1:0]=01	200	300	400	mV
		R _{ML0_DRV} [1:0]=10	300	400	500	mV
PRE	CML Pre-emphasis level	R _{ML0_PRE} [1:0]=00	-	0	-	%
		R _{ML0_PRE} [1:0]=01	40	50	60	%
		R _{ML0_DRV} [1:0]=00/01	80	100	120	%
		R _{ML0_PRE} [1:0]=10	-	-	-	%
V _{TOC}	CML Common Mode Output Voltage	R _{ML0_PRE} [1:0]=00	-	V _{DDA} - V _{TOD}	-	V
		R _{ML0_PRE} [1:0]=01	-	V _{DDA} - 1.5*V _{TOD}	-	V
		R _{ML0_PRE} [1:0]=10	-	V _{DDA} - 2*V _{TOD}	-	V
I _{TOZH}	CML Output Leak Current High	R _{TX_SNRST} =1	-10	-	10	uA
I _{TOZL}	CML Output Leak Current Low	R _{TX_SNRST} =1	-30	-	10	uA
I _{TOS}	CML Output Short Circuit Current	R _{TX_SNRST} =0 or PDN0=0 V _{DDA} =1.20v	-	-48	-	mA

10.3 CML Bi-directional Buffer DC Specifications

Table 55. CML Bi-directional Buffer DC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
VBTH	CML Bi-Directional Buffer Differential Input High Threshold	R_BDCZ_HYS=0	-	-	50	mV
		R_BDCZ_HYS=1	-	-	150	mV
VBTL	CML Bi-Directional Buffer Differential Input Low Threshold	R_BDCZ_HYS=0	-50	-	-	mV
		R_BDCZ_HYS=1	-150	-	-	mV
VBIC	CML Bi-Directional Buffer Input Terminated Common Voltage	R_BDCZ_TERM_** [1:0]=2'b00 R_BDCZ_DRIVE_** DRIVE[1:0]=2'b00	-	VDDB-300	-	mV
IBIH	CML Bi-Directional Buffer Output Leak Current High	TCMP/N=VDDH	-10	-	10	uA
IBIL	CML Bi-Directional Buffer Output Leak Current Low	TCMP/N=0V	-10	-	10	uA
VBOD	CML Bi-Directional Buffer Differential Output Voltage	R_BDCZ_TERM_** [1:0]=2'b10 R_BDCZ_DRIVE_** [1:0]=2'b10 Diff. 100ohm terminated	200	300	400	mV
VBOC	CML Bi-Directional Buffer Common Output Voltage	R_BDCZ_TERM_** [1:0]=2'b00 R_BDCZ_DRIVE_** [1:0]=2'b00	-	VDDB-300	-	mV
IBOZ	CML Bi-Directional Buffer TRI-STATE Current	PDN1=0	-10	-	10	uA
RTERM	CML Bi-Directional Buffer Termination Resistance	R_BDCZ_TERM_TX/ RX [1:0]=2'b10	-	50	-	ohm
		R_BDCZ_TERM_TX/ RX [1:0]=2'b01	-	100	-	ohm
		R_BDCZ_TERM_TX/ RX [1:0]=2'b00	-	200	-	ohm
IDRIVE	CML Bi-Directional Buffer Drive Current	R_BDCZ_DRIVE_TX/ RX [1:0]=2'b10	-	12	-	mA
		R_BDCZ_DRIVE_TX/ RX [1:0]=2'b01	-	6	-	mA
		R_BDCZ_DRIVE_TX/ RX [1:0]=2'b00	-	3	-	mA

11 AC Specifications

11.1 General AC Specifications

Table 56. General AC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
tDL	Data Latency	MainLink 4Gbps	Typ.-98	3350	Typ.+98	ns

11.2 MIPI Receiver AC Specifications

Table 57. MIPI Receiver AC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
UI	Unit Interval	-	0.833	-	12.5	ns

11.3 CML Transmitter AC Specifications

Table 58. CML Transmitter AC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
tTRF	CML Tx Output Rise and Fall Time	-	50	-	150	ps

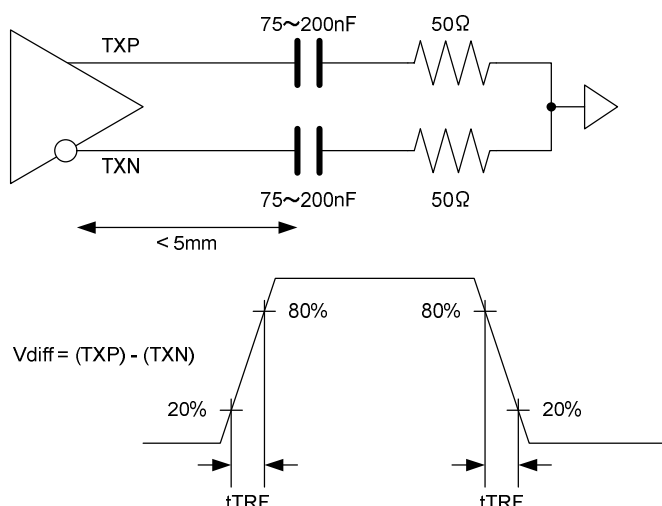


Figure 24. CML Transmitter tTRF

11.4 CML B-directional Buffer AC Specifications

Table 59. CML B-directional Buffer AC Specifications

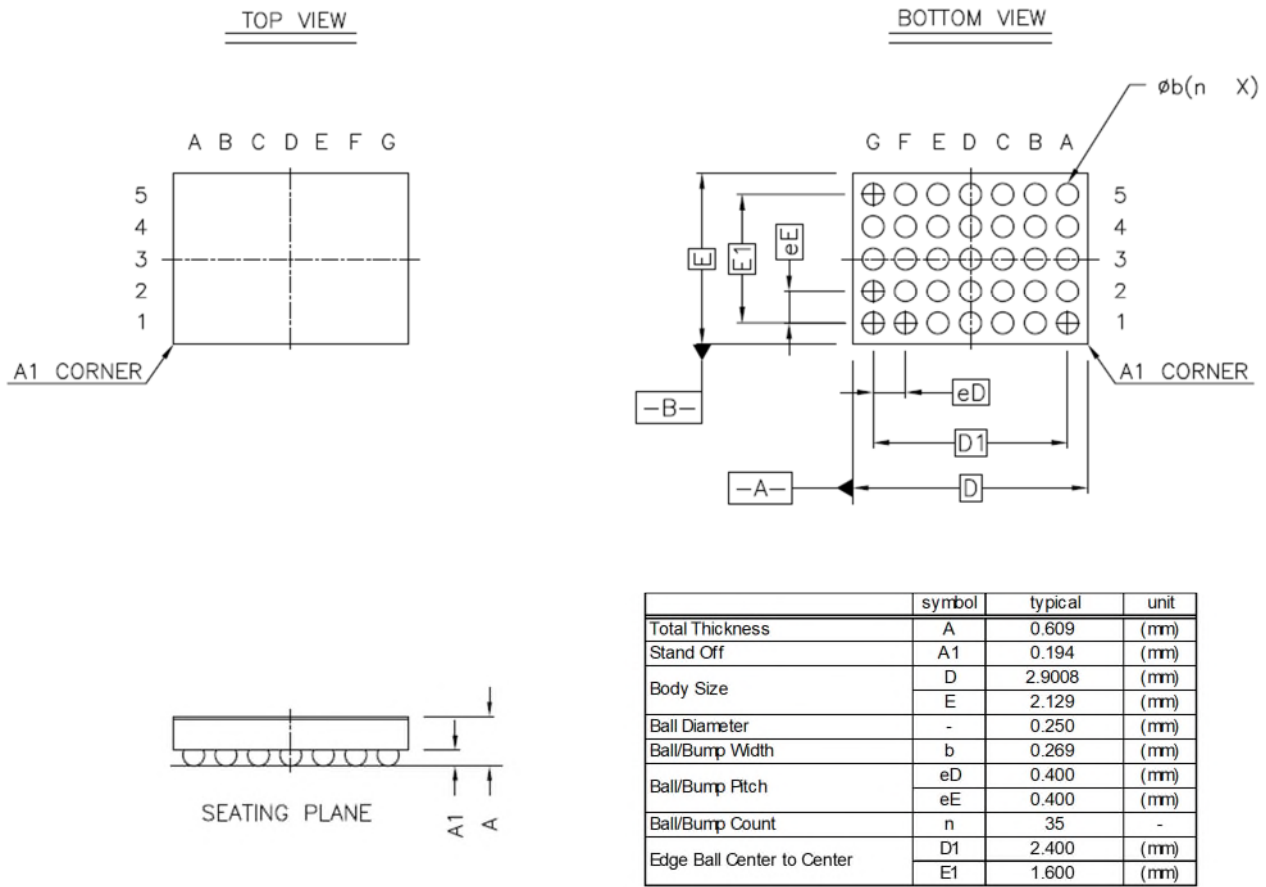
Symbol	Parameter	Condition	Min	Typ	Max	Unit
tBUI	Bi-Directional CML Buffer Unit Interval	REG0x0076/F6 = 0x15	128.7	137.5	172.7	ns

11.5 2-wire serial AC Specifications

Table 60. 2-wire serial AC Specifications

Symbol	Parameter	Condition	Min	Typ	Max	Unit
tOSC	Cycle of internal oscillator clock	-	11.7	12.5	15.7	ns
fSCL	SCL clock frequency	-	-	-	1000	kHz

12 Package



13 Notices and Requests

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